

# 采用小型封装的 TPS7A05 1 $\mu$ A 超低 I<sub>Q</sub> 200mA 低压降稳压器

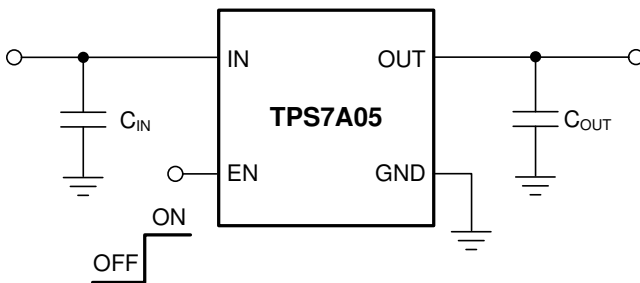
## 1 特性

- 超低 I<sub>Q</sub>: 1 $\mu$ A (典型值)、3 $\mu$ A (最大值)
  - I<sub>GND</sub>: 在 200mA 下为 6 $\mu$ A (典型值)
- 绝佳的瞬态响应
- 封装:
  - 1.0mm x 1.0mm X2SON (4)
  - 0.65mm x 0.65mm DSBGA (4)
  - SOT-23 (5)
  - SOT-23 (3)
- 输入电压范围: 1.4V 至 5.5V
- 输出精度: 1% 典型值, 3% 最大值
- 可提供固定输出电压:
  - 0.8V 至 3.3V
- 非常低的压降:
  - 200mA 时为 235mV (最大值) (3.3V<sub>OUT</sub>)
- 有源输出放电
- 折返电流限制
- 与 0.47 $\mu$ F 或更大的电容器一起工作时保持稳定

## 2 应用

- 可穿戴电子产品
- 超极本、平板电脑、电子阅读器
- 始终通电型电源
- 机顶盒
- 游戏控制器、遥控器、玩具、无人机
- 无线手持终端和智能手机
- 便携式和电池供电类设备

典型应用电路



## 3 说明

TPS7A05 是一款超小型低静态电流低压降稳压器 (LDO), 可提供 200mA 的电流以及出色的瞬态性能。该器件的输出范围为 0.8V 至 3.3V, 典型精度为 1%。

TPS7A05 具有超低 I<sub>Q</sub> (1 $\mu$ A), 消耗的静态电流极低, 从而能够在电池供电应用中延长电池寿命提供了出色的功能性与安全性。该器件可由可再充电的锂离子电池、锂原电池化学物质 (如 Li-SOCl<sub>2</sub>、Li-MnO<sub>2</sub>) 以及两到三节碱性电池供电。

TPS7A05 采用有源下拉电路, 用于在器件处于禁用状态时对输出进行快速放电。

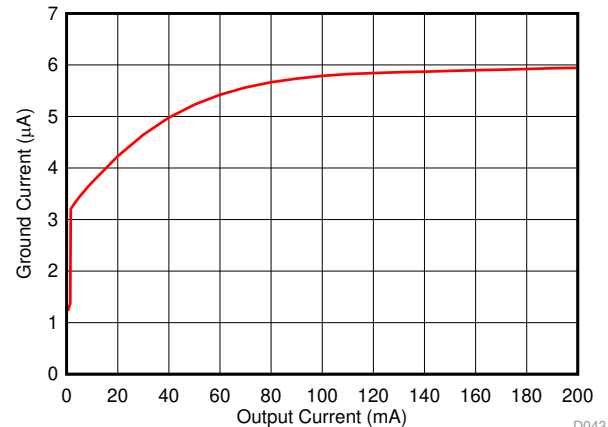
TPS7A05 的完整额定工作温度范围为 T<sub>J</sub> = -40°C 至 +125°C, 采用标准的 X2SON (DQN)、SOT-23 (DBV 和 DBZ) 以及 DSBGA (YKA) 封装。

器件信息<sup>(1)</sup>

| 器件型号    | 封装         | 封装尺寸 (标称值)      |
|---------|------------|-----------------|
| TPS7A05 | X2SON (4)  | 1.00mm x 1.00mm |
|         | DSBGA (4)  | 0.65mm x 0.65mm |
|         | SOT-23 (5) | 2.90mm x 1.60mm |
|         | SOT-23 (3) | 2.90mm x 1.60mm |

(1) 如需了解所有可用封装, 请参阅数据表末尾的封装选项附录。

接地电流与输出电流间的关系



D043



目录

|     |  |    |      |   |    |
|-----|--|----|------|---|----|
| 1   | 特性 .....                                     | 1  | 7.4  | Device Functional Modes .....               | 21 |
| 2   | 应用 .....                                     | 1  | 8    | <b>Application and Implementation</b> ..... | 22 |
| 3   | 说明 .....                                     | 1  | 8.1  | Application Information .....               | 22 |
| 4   | 修订历史记录 .....                                 | 2  | 8.2  | Typical Application .....                   | 27 |
| 5   | <b>Pin Configuration and Functions</b> ..... | 4  | 9    | <b>Power Supply Recommendations</b> .....   | 27 |
| 6   | <b>Specifications</b> .....                  | 6  | 10   | <b>Layout</b> .....                         | 28 |
| 6.1 | Absolute Maximum Ratings .....               | 6  | 10.1 | Layout Guidelines .....                     | 28 |
| 6.2 | ESD Ratings .....                            | 6  | 10.2 | Layout Example .....                        | 28 |
| 6.3 | Recommended Operating Conditions .....       | 6  | 11   | <b>器件和文档支持</b> .....                        | 29 |
| 6.4 | Thermal Information .....                    | 6  | 11.1 | 器件支持 .....                                  | 29 |
| 6.5 | Electrical Characteristics .....             | 7  | 11.2 | 文档支持 .....                                  | 29 |
| 6.6 | Switching Characteristics .....              | 9  | 11.3 | 接收文档更新通知 .....                              | 29 |
| 6.7 | Typical Characteristics .....                | 10 | 11.4 | 社区资源 .....                                  | 29 |
| 7   | <b>Detailed Description</b> .....            | 18 | 11.5 | 商标 .....                                    | 29 |
| 7.1 | Overview .....                               | 18 | 11.6 | 静电放电警告 .....                                | 29 |
| 7.2 | Functional Block Diagram .....               | 18 | 11.7 | Glossary .....                              | 29 |
| 7.3 | Feature Description .....                    | 19 | 12   | <b>机械、封装和可订购信息</b> .....                    | 30 |

4 修订历史记录

| Changes from Revision C (April 2019) to Revision D   | Page |
|--|------|
| • 已更改 将 DBZ 封装从 APL 更改为生产数据 .....  | 1    |
| • Added DBZ package to <i>Load Regulation</i> parameter in <i>Electrical Characteristics</i> table ..... | 7    |
| • Added DBZ package to <i>Dropout voltage</i> parameter in <i>Electrical Characteristics</i> table ..... | 8    |
| • 已添加 condition statement to <i>I<sub>Q</sub> vs V<sub>IN</sub> and Temperature</i> figure .....         | 10   |

| Changes from Revision B (August 2018) to Revision C | Page |
|---|------|
| • 已添加 向文档添加了 DBZ 封装（作为 APL 发行版） .....               | 1    |

| Changes from Revision A (May 2018) to Revision B  | Page |
|---|------|
| • 已更改 在文档标题中将 <i>1mm x 1mm</i> 更改成了小型 .....   | 1    |
| • 已更改 将 YKA (DSBGA) 封装状态更改成了“生产数据” .....  | 1    |
| • Added Accuracy for 1.825 V in <i>Electrical Characteristics</i> table .....   | 7    |
| • Changed Output current limit in <i>Electrical Characteristics</i> table .....   | 7    |
| • Added Output current limit for +85°C in <i>Electrical Characteristics</i> table .....   | 7    |
| • Changed Short-circuit current limit in <i>Electrical Characteristics</i> table .....  | 7    |
| • Added Dropout voltage for 1.825 V in <i>Electrical Characteristics</i> table .....  | 8    |
| • 已更改 y-axis scaling and added conditions for <i>I<sub>OUT</sub> Transient 0 mA to 100 mA</i> figure .....  | 10   |
| • 已更改 y-axis scaling and added conditions for <i>I<sub>OUT</sub> Transient 0 mA to 200 mA</i> figure .....  | 11   |
| • 已添加 <i>I<sub>OUT</sub> Transient 0 mA to 50 mA</i> figure to <i>I<sub>OUT</sub> Transient 3 μA to 3 mA</i> figure .....                         | 11   |
| • 已添加 slew rate condition to <i>V<sub>IN</sub> Transient</i> figures ( <i>I<sub>OUT</sub></i> = 100 mA and <i>I<sub>OUT</sub></i> = 200 mA) ..... | 12   |
| • 已添加 <i>V<sub>IN</sub> Transient</i> figures ( <i>I<sub>OUT</sub></i> = 150 mA and <i>I<sub>OUT</sub></i> = 20 mA) .....                         | 13   |
| • 已添加 <i>V<sub>IN</sub></i> condition to <i>PSRR vs Frequency and I<sub>OUT</sub></i> figure ( <i>V<sub>OUT</sub></i> = 1.8 V) .....              | 16   |

---

**Changes from Original (February 2018) to Revision A**

**Page**

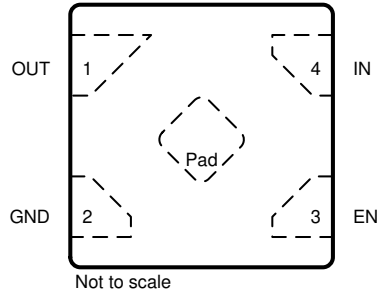
---

|                |   |
|----------------|---|
| • 已发布至生产 ..... | 1 |
|----------------|---|

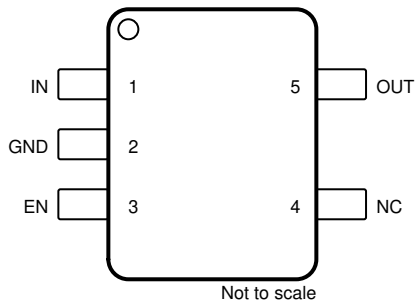
---

## 5 Pin Configuration and Functions

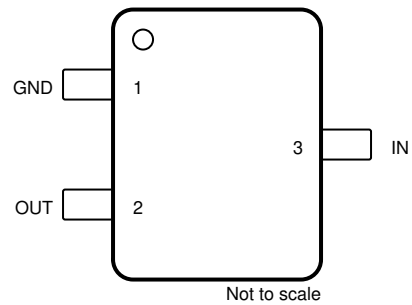
**DQN Package**  
1-mm × 1-mm, 4-Pin X2SON  
Top View



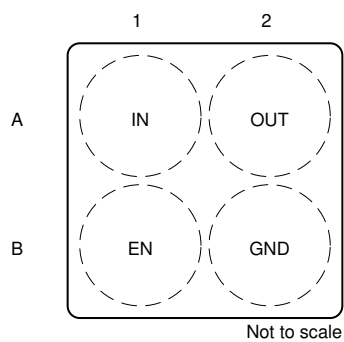
**DBV Package**  
5-Pin SOT-23  
Top View



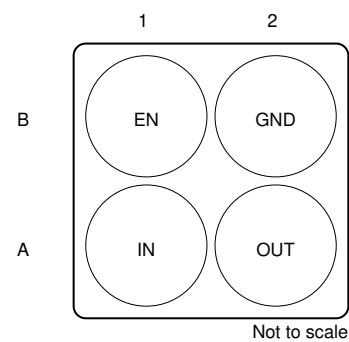
**DBZ Package**  
3-Pin SOT-23  
Top View



**YKA Package**  
4-Pin DSBGA, 0.35-mm Pitch  
Top View



**YKA Package**  
4-Pin DSBGA, 0.35-mm Pitch  
Bottom View



### Pin Functions

| NAME        | PIN |     |     |     | I/O    | DESCRIPTION   |
|-------------|-----|-----|-----|-----|--------|---|
|             | DQN | DBV | DBZ | YKA |        |   |
| IN          | 4   | 1   | 3   | A1  | Input  | Input pin. For best transient response and to minimize input impedance, use the recommended value or larger ceramic capacitor from IN to ground as listed in the <a href="#">Recommended Operating Conditions</a> table. Place the input capacitor as close to input of the device as possible.   |
| EN          | 3   | 3   | —   | B1  | Input  | Enable pin. Driving this pin to logic high enables the device; driving this pin to logic low disables the device. If enable functionality is not required, this pin must be connected to IN. $V_{EN}$ must not exceed $V_{IN}$ .  |
| GND         | 2   | 2   | 1   | B2  | —      | Ground pin. This pin must be connected to ground on the board.  |
| OUT         | 1   | 5   | 2   | A2  | Output | Regulated output pin. A capacitor is required from OUT to ground for stability. For best transient response, use the nominal recommended value or larger ceramic capacitor from OUT to ground. Follow the recommended capacitor value as listed in the <a href="#">Recommended Operating Conditions</a> table. Place the output capacitor as close to output of the device as possible. |
| NC          | —   | 4   | —   | —   | —      | No connect pin. This pin is not internally connected. Connect to ground or leave floating.  |
| Thermal pad | Pad | —   | —   | —   | —      | Connect the thermal pad to a large-area ground plane. This pad is not an electrical connection to the device ground.  |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                        |  | MIN                | MAX   | UNIT |
|------------------------|--|--------------------|---|------|
| Voltage <sup>(2)</sup> | IN   | -0.3               | 6.0   | V    |
|                        | EN   | -0.3               | V <sub>IN</sub> + 0.3                       |      |
|                        | OUT  | -0.3               | V <sub>IN</sub> + 0.3 or 3.6 <sup>(3)</sup> |      |
| Current                | Maximum output current                         | Internally limited |   | A    |
| Temperature            | Operating junction temperature, T <sub>J</sub> | -40                | 125   | °C   |
|                        | Storage temperature, T <sub>stg</sub>          | -65                | 150   |      |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltages with respect to GND.
- (3) V<sub>IN</sub> + 0.3 V or 3.6 V (whichever is smaller)

### 6.2 ESD Ratings

|                    |                         |  | VALUE | UNIT |
|--------------------|-------------------------|--|-------|------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±1000 | V    |
|                    |                         | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±500  |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

|                  |                                | MIN  | NOM | MAX             | UNIT |
|------------------|--------------------------------|------|-----|-----------------|------|
| V <sub>IN</sub>  | Input supply voltage           | 1.4  |     | 5.5             | V    |
| V <sub>EN</sub>  | Enable supply voltage          | 0    |     | V <sub>IN</sub> | V    |
| V <sub>OUT</sub> | Nominal output voltage range   | 0.8  |     | 3.3             | V    |
| I <sub>OUT</sub> | Output current <sup>(1)</sup>  | 0    |     | 200             | mA   |
| C <sub>IN</sub>  | Input capacitor                |      | 1   |                 | µF   |
| C <sub>OUT</sub> | Output capacitor               | 0.47 | 1   | 22              | µF   |
| T <sub>J</sub>   | Operating junction temperature | -40  |     | 125             | °C   |

- (1) Output current of 10 µA minimum required to meet output voltage accuracy specification.

### 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |  | TPS7A05      |              |             |             | UNIT |
|-------------------------------|--|--------------|--------------|-------------|-------------|------|
|                               |  | DBZ (SOT-23) | DBV (SOT-23) | DQN (X2SON) | YKA (DSBGA) |      |
|                               |  | 3 PINS       | 5 PINS       | 4 PINS      | 4 PINS      |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 267.3        | 185.6        | 144.1       | 198.0       | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 103.5        | 104.3        | 137.9       | 2.1         | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 98.0         | 54.5         | 83.5        | 66.9        | °C/W |
| Ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 9.2          | 31.0         | 5.3         | 0.9         | °C/W |
| Y <sub>JB</sub>               | Junction-to-board characterization parameter | 97.4         | 54.5         | 83.8        | 76.0        | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance | n/a          | n/a          | 71.8        | n/a         | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.5 Electrical Characteristics

specified at  $T_J = -40^\circ\text{C}$  to  $+125^\circ\text{C}$ ,  $V_{IN} = V_{OUT(nom)} + 0.5\text{ V}$  or  $1.4\text{ V}$  (whichever is greater),  $I_{OUT} = 1\text{ mA}$ ,  $V_{EN} = V_{IN}$ ,  $C_{IN} = 1\text{ }\mu\text{F}$ , and  $C_{OUT} = 1\text{ }\mu\text{F}$  (unless otherwise noted); typical values are at  $T_J = 25^\circ\text{C}$ .

| PARAMETER                                | TEST CONDITIONS  | MIN  | TYP | MAX  | UNIT |               |
|--|--|--|-----|------|------|---------------|
| Nominal accuracy <sup>(1)</sup>          | $V_{OUT} \geq 1.0\text{ V}$ , $T_J = 25^\circ\text{C}$   | -1%  |     | 1%   | mV   |               |
|  | $V_{OUT} < 1.0\text{ V}$ , $T_J = 25^\circ\text{C}$  | -10  |     | 10   |      |               |
| Accuracy over temperature <sup>(1)</sup> | $V_{OUT} \geq 1.0\text{ V}$ , $T_J = -40^\circ\text{C}$ to $+85^\circ\text{C}$   | -2%  |     | 2%   | mV   |               |
|  | $V_{OUT} \geq 1.0\text{ V}$  | -3%  |     | 3%   |      |               |
|  | $V_{OUT} < 1.0\text{ V}$ , $T_J = -40^\circ\text{C}$ to $+85^\circ\text{C}$  | -20  |     | 20   |      |               |
|  | $V_{OUT} < 1.0\text{ V}$   | -30  |     | 30   |      |               |
|  | $V_{OUT} = 1.825\text{ V}$ , $T_J = +10^\circ\text{C}$ to $+45^\circ\text{C}$ ,<br>$I_{OUT} = 100\text{ }\mu\text{A}$  | -0.9%  |     | 0.9% |      |               |
| $\Delta V_{OUT(\Delta V_{IN})}$          | $V_{OUT(nom)} + 0.5\text{ V} \leq V_{IN} \leq 5.5\text{ V}^{(2)}$ ,<br>$T_J = -40^\circ\text{C}$ to $+85^\circ\text{C}$  |  | 5   | 16.5 | mV   |               |
|  | $V_{OUT(nom)} + 0.5\text{ V} \leq V_{IN} \leq 5.5\text{ V}^{(2)}$  |  |     | 18   |      |               |
| $\Delta V_{OUT(\Delta I_{OUT})}$         | $100\text{ }\mu\text{A} \leq I_{OUT} \leq 200\text{ mA}$ ,<br>$V_{IN} = V_{OUT(nom)} + V_{DO(max)} + 0.1\text{ V}$ ,<br>$T_J = -40^\circ\text{C}$ to $+85^\circ\text{C}$ | DBV, DQN, YKA  | 20  | 43   | mV   |               |
|  |  | DBZ  | 27  | 50   |      |               |
|  | $100\text{ }\mu\text{A} \leq I_{OUT} \leq 200\text{ mA}$ ,<br>$V_{IN} = V_{OUT(nom)} + V_{DO(max)} + 0.1\text{ V}$   | DBV, DQN, YKA  |     | 55   |      |               |
|  |  | DBZ  |     | 62   |      |               |
| $I_{GND}$                                | Ground current   | $T_J = 25^\circ\text{C}$ , $I_{OUT} = 1\text{ }\mu\text{A}$  | 0.6 | 1    | 1.3  | $\mu\text{A}$ |
|  |  | $I_{OUT} = 1\text{ }\mu\text{A}$ , $T_J = -40^\circ\text{C}$ to $+85^\circ\text{C}$  |     |      | 2    |               |
|  |  | $I_{OUT} = 1\text{ }\mu\text{A}$   |     |      | 3    |               |
| $I_{SHDN}$                               | Shutdown current   | $V_{EN} = 0.4\text{ V}$ , $1.4\text{ V} \leq V_{IN} \leq 5.5\text{ V}$ , $T_J = 25^\circ\text{C}$  |     |      | nA   |               |
| $I_{CL}$                                 | Output current limit   | $V_{OUT} = 90\% \times V_{OUT(nom)}$ , $V_{IN} = V_{OUT(nom)} + V_{DO(max)} + 0.5\text{ V}$  |     |      | mA   |               |
| $I_{CL}$                                 | Output current limit   | $V_{OUT} = 90\% \times V_{OUT(nom)}$ ,<br>$V_{IN} = V_{OUT(nom)} + V_{DO(max)} + 0.5\text{ V}$ ,<br>$T_J = 0^\circ\text{C}$ to $+85^\circ\text{C}$ |     |      | mA   |               |
| $I_{SC}$                                 | Short-circuit current limit  | $V_{OUT} = 0\text{ V}$   |     |      | mA   |               |

(1)  $I_{OUT} \geq 10\text{ }\mu\text{A}$  required to meet accuracy specifications.

(2)  $V_{IN} = 1.4\text{ V}$  for  $V_{OUT} \leq 0.9\text{ V}$ .

(3) Load Regulation is normalized to the output voltage at  $I_{OUT} = 1\text{ mA}$ .

**Electrical Characteristics (continued)**

specified at  $T_J = -40^\circ\text{C}$  to  $+125^\circ\text{C}$ ,  $V_{IN} = V_{OUT(nom)} + 0.5\text{ V}$  or  $1.4\text{ V}$  (whichever is greater),  $I_{OUT} = 1\text{ mA}$ ,  $V_{EN} = V_{IN}$ ,  $C_{IN} = 1\text{ }\mu\text{F}$ , and  $C_{OUT} = 1\text{ }\mu\text{F}$  (unless otherwise noted); typical values are at  $T_J = 25^\circ\text{C}$ .

| PARAMETER  | TEST CONDITIONS                            |  | MIN  | TYP | MAX                 | UNIT             |
|--|--|--|--|-----|---------------------|------------------|
| $V_{DO}$   | Dropout voltage <sup>(4)</sup>             | $I_{OUT} = 200\text{ mA}$ ,<br>$T_J = -40^\circ\text{C}$ to $+85^\circ\text{C}$                  | $0.8\text{ V} \leq V_{OUT} < 1.0\text{ V}$ |     | 915                 | mV               |
|  |  |  | $1.0\text{ V} \leq V_{OUT} < 1.2\text{ V}$ |     | 758                 |                  |
|  |  |  | $1.2\text{ V} \leq V_{OUT} < 1.5\text{ V}$ |     | 609                 |                  |
|  |  |  | $1.5\text{ V} \leq V_{OUT} < 1.8\text{ V}$ |     | 469                 |                  |
|  |  |  | $1.8\text{ V} \leq V_{OUT} < 2.5\text{ V}$ |     | 341                 |                  |
|  |  |  | $2.5\text{ V} \leq V_{OUT} < 3.3\text{ V}$ |     | 275                 |                  |
|  |  |  | $V_{OUT} = 3.3\text{ V}$                   |     | 212                 |                  |
|  |  | $I_{OUT} = 200\text{ mA}$  | $0.8\text{ V} \leq V_{OUT} < 1.0\text{ V}$ |     | 1004                |                  |
|  |  |  | $1.0\text{ V} \leq V_{OUT} < 1.2\text{ V}$ |     | 837                 |                  |
|  |  |  | $1.2\text{ V} \leq V_{OUT} < 1.5\text{ V}$ |     | 679                 |                  |
|  |  |  | $1.5\text{ V} \leq V_{OUT} < 1.8\text{ V}$ |     | 525                 |                  |
|  |  |  | $1.8\text{ V} \leq V_{OUT} < 2.5\text{ V}$ |     | 382                 |                  |
|  |  |  | $2.5\text{ V} \leq V_{OUT} < 3.3\text{ V}$ |     | 308                 |                  |
|  |  |  | $V_{OUT} = 3.3\text{ V}$                   |     | 235                 |                  |
|  |  | $I_{OUT} = 200\text{ mA}$ ,<br>$T_J = -40^\circ\text{C}$ to $+85^\circ\text{C}$ ,<br>DBZ Package | $1.8\text{ V} \leq V_{OUT} < 2.5\text{ V}$ |     | 351                 |                  |
|  |  |  | $2.5\text{ V} \leq V_{OUT} < 3.3\text{ V}$ |     | 285                 |                  |
|  |  |  | $V_{OUT} = 3.3\text{ V}$                   |     | 222                 |                  |
| $I_{OUT} = 200\text{ mA}$ ,<br>DBZ Package   | $1.8\text{ V} \leq V_{OUT} < 2.5\text{ V}$ |  | 392  |     |                     |                  |
|  | $2.5\text{ V} \leq V_{OUT} < 3.3\text{ V}$ |  | 318  |     |                     |                  |
|  | $V_{OUT} = 3.3\text{ V}$                   |  | 245  |     |                     |                  |
| $I_{OUT} = 100\text{ }\mu\text{A}$ ,<br>$T_J = +10^\circ\text{C}$ to $+45^\circ\text{C}$ | $V_{OUT} = 1.825\text{ V}$                 |  | 20   |     |                     |                  |
|  |  |  |  |     |                     |                  |
| PSRR   | Power-supply rejection ratio               | $f = 1\text{ kHz}$ , $I_{OUT} = 30\text{ mA}$  |  | 40  | dB                  |                  |
|  |  | $f = 500\text{ kHz}$ , $I_{OUT} = 30\text{ mA}$  |  | 30  |                     |                  |
|  |  | $f = 1\text{ MHz}$ , $I_{OUT} = 30\text{ mA}$  |  | 40  |                     |                  |
| $V_N$  | Output voltage noise                       | $BW = 10\text{ Hz}$ to $100\text{ kHz}$ , $V_{OUT} = 1.2\text{ V}$ ,<br>$I_{OUT} = 30\text{ mA}$ |  | 180 | $\mu\text{V}_{RMS}$ |                  |
| $V_{UVLO}$   | UVLO threshold                             | $V_{IN}$ rising  | 1.21                                       | 1.3 | 1.37                | V                |
| $V_{UVLO(HYST)}$   | UVLO hysteresis                            | $V_{IN}$ falling   |  | 40  |                     | mV               |
| $V_{UVLO}$   | UVLO threshold                             | $V_{IN}$ falling   | 1.17                                       |     | 1.33                | V                |
| $V_{EN(HI)}$   | EN pin logic high voltage                  |  | 0.9  |     |                     | V                |
| $V_{EN(LO)}$   | EN pin logic low voltage                   |  |  |     | 0.4                 | V                |
| $I_{EN}$   | EN pin current                             | $V_{EN} = V_{IN} = 5.5\text{ V}$   |  | 10  |                     | nA               |
| $R_{PULLDOWN}$   | Pulldown resistor                          | $V_{IN} = 3.3\text{ V}$ , P version only   |  | 120 |                     | $\Omega$         |
| $T_{sd}$   | Thermal shutdown temperature               | Shutdown, temperature increasing   |  | 160 |                     | $^\circ\text{C}$ |
|  |  | Reset, temperature decreasing  |  | 140 |                     |                  |

(4) Dropout is measured by ramping  $V_{IN}$  down until  $V_{OUT} = V_{OUT(nom)} - 5\%$ .



## 6.6 Switching Characteristics

specified at  $T_J = -40$  to  $+125^\circ\text{C}$ ,  $V_{IN} = V_{OUT(nom)} + V_{DO(max)} + 0.5\text{ V}$ ,  $I_{OUT} = 10\text{ mA}$ ,  $C_{IN} = 1\ \mu\text{F}$ , and  $C_{OUT} = 1\ \mu\text{F}$  (unless otherwise noted); typical values are at  $T_J = 25^\circ\text{C}$ .

| PARAMETER |                              | TEST CONDITIONS  | MIN | TYP | MAX | UNIT |
|-----------|------------------------------|--|-----|-----|-----|------|
| $t_{STR}$ | Start-up time <sup>(1)</sup> | From EN assertion to $V_{OUT} = 95\% \times V_{OUT(nom)}$ , $V_{OUT} = 1.8\text{ V}$ |     | 1.5 | 2.8 | ms   |

- (1) See the [Special Considerations When Ramping Down IN and Enable](#) section for details on minimum ramp down rates to ensure specified start-up time.

### 6.7 Typical Characteristics

at operating temperature  $T_J = 25^\circ\text{C}$ ,  $V_{IN} = V_{OUT(NOM)} + 0.5\text{ V}$  or  $2.0\text{ V}$  (whichever is greater),  $I_{OUT} = 1\text{ mA}$ ,  $V_{EN} = V_{IN}$ ,  $C_{IN} = 1\text{ }\mu\text{F}$ , and  $C_{OUT} = 1\text{ }\mu\text{F}$  (unless otherwise noted)

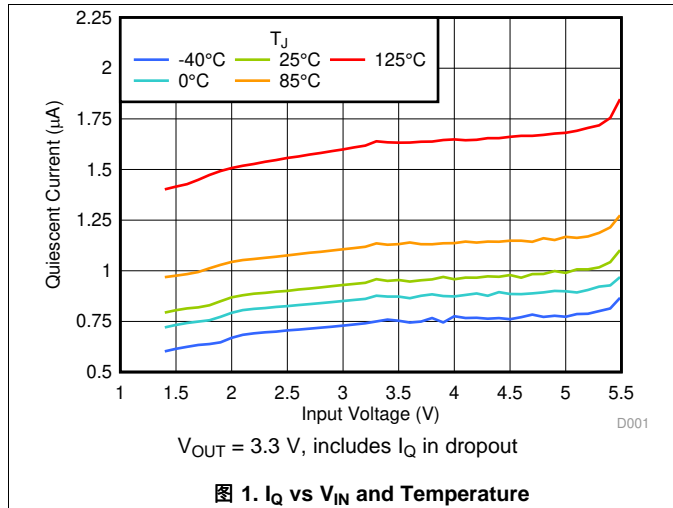


图 1.  $I_Q$  vs  $V_{IN}$  and Temperature

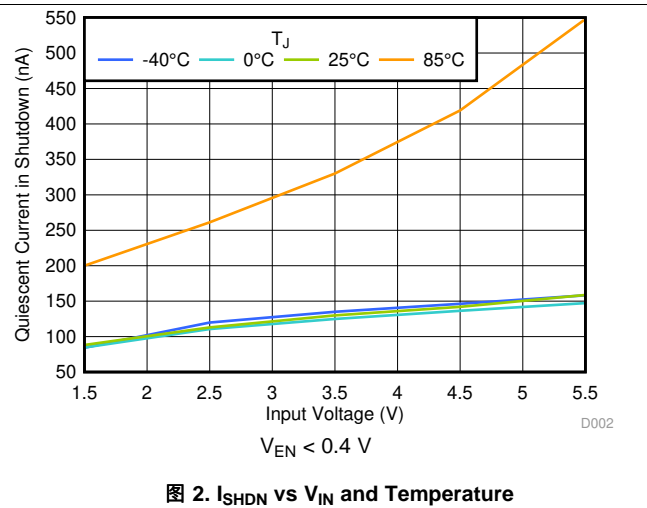


图 2.  $I_{SHDN}$  vs  $V_{IN}$  and Temperature

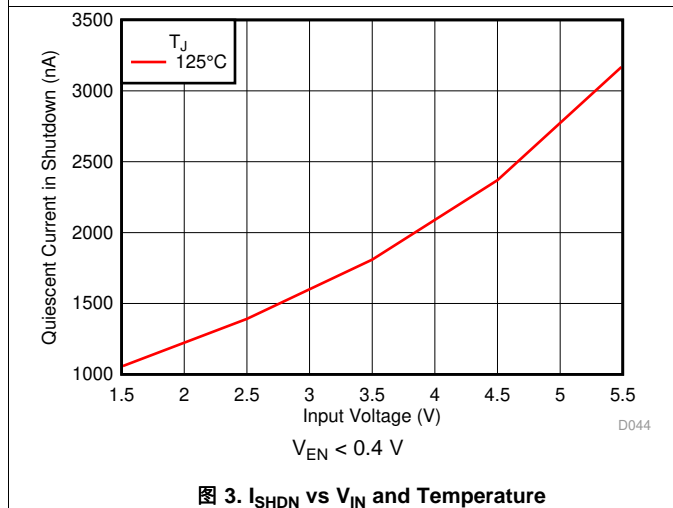


图 3.  $I_{SHDN}$  vs  $V_{IN}$  and Temperature

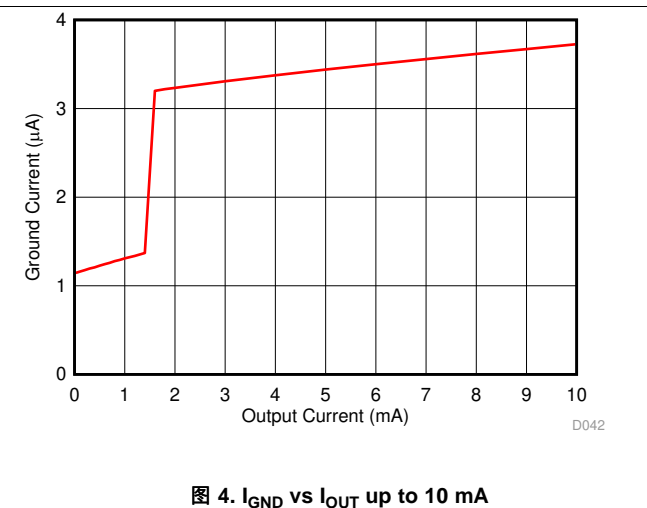


图 4.  $I_{GND}$  vs  $I_{OUT}$  up to 10 mA

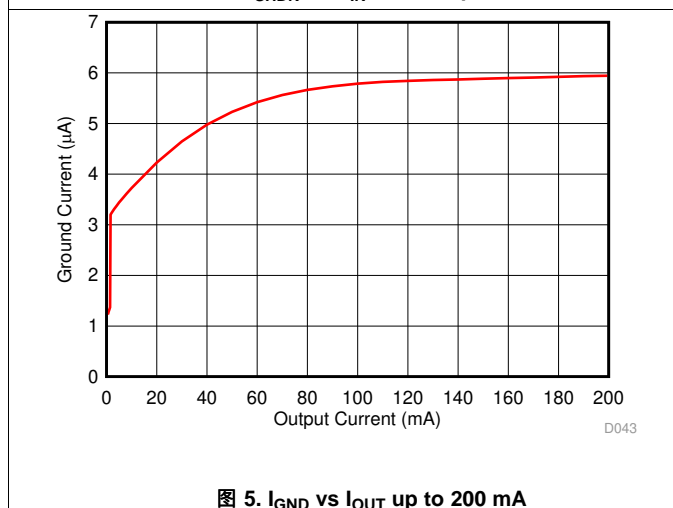


图 5.  $I_{GND}$  vs  $I_{OUT}$  up to 200 mA

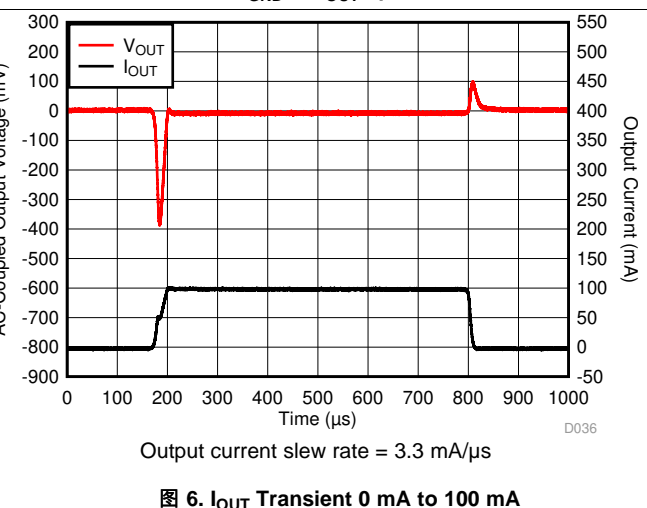
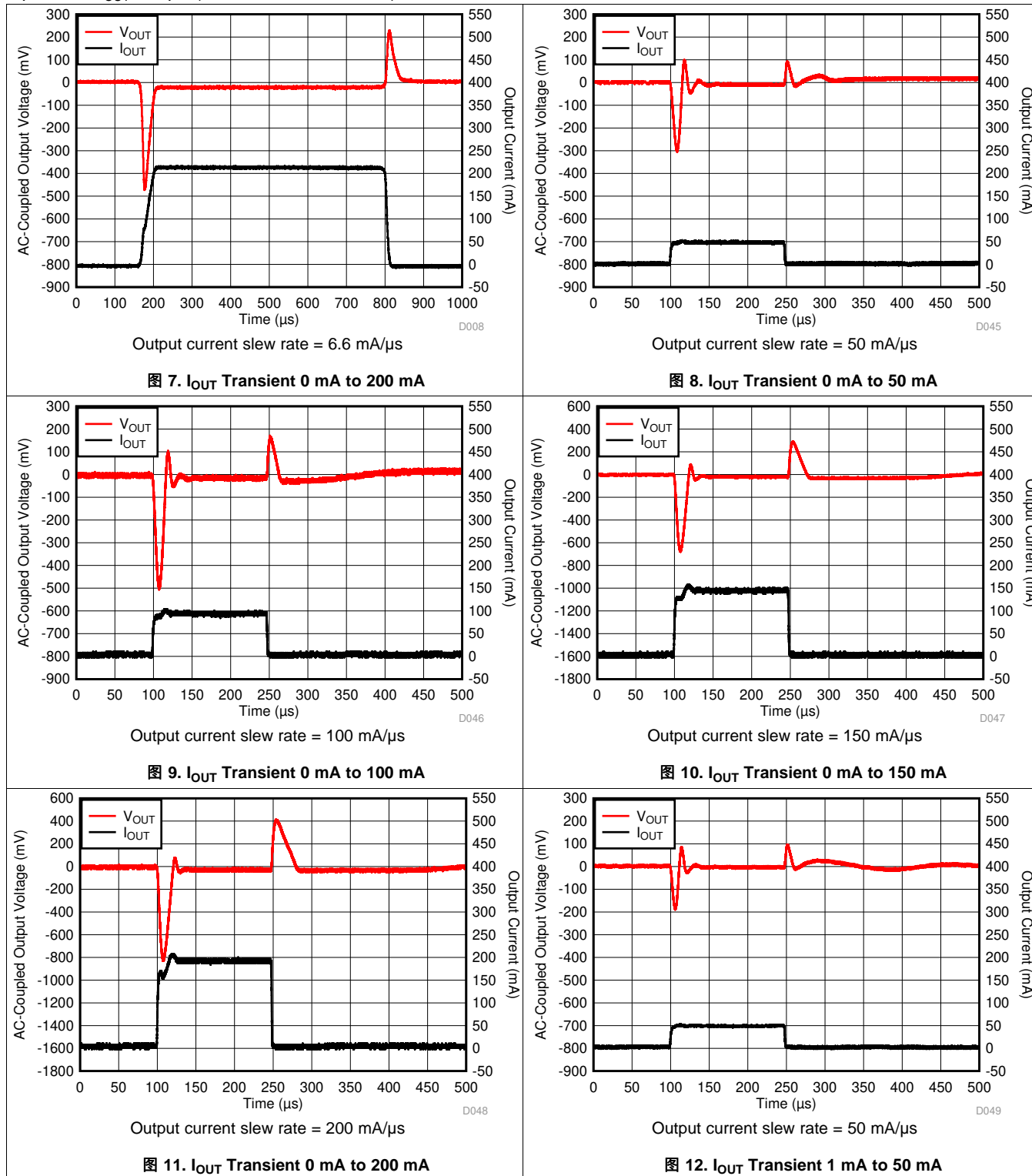


图 6.  $I_{OUT}$  Transient 0 mA to 100 mA

Typical Characteristics (接下页)

at operating temperature  $T_J = 25^\circ\text{C}$ ,  $V_{IN} = V_{OUT(NOM)} + 0.5\text{ V}$  or  $2.0\text{ V}$  (whichever is greater),  $I_{OUT} = 1\text{ mA}$ ,  $V_{EN} = V_{IN}$ ,  $C_{IN} = 1\text{ }\mu\text{F}$ , and  $C_{OUT} = 1\text{ }\mu\text{F}$  (unless otherwise noted)



Typical Characteristics (接下页)

at operating temperature  $T_J = 25^\circ\text{C}$ ,  $V_{IN} = V_{OUT(NOM)} + 0.5\text{ V}$  or  $2.0\text{ V}$  (whichever is greater),  $I_{OUT} = 1\text{ mA}$ ,  $V_{EN} = V_{IN}$ ,  $C_{IN} = 1\text{ }\mu\text{F}$ , and  $C_{OUT} = 1\text{ }\mu\text{F}$  (unless otherwise noted)

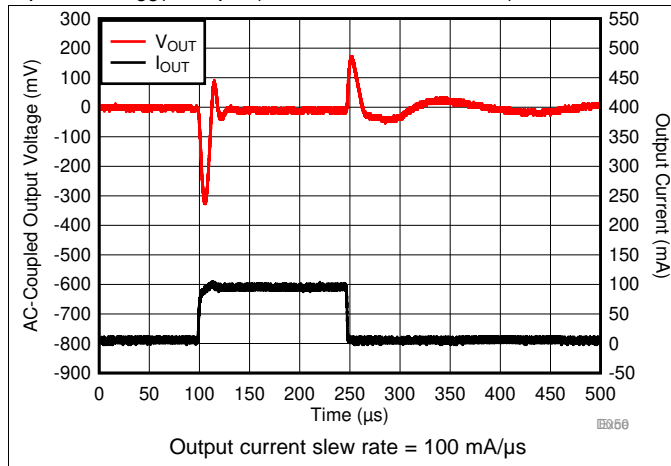


图 13.  $I_{OUT}$  Transient 1 mA to 100 mA

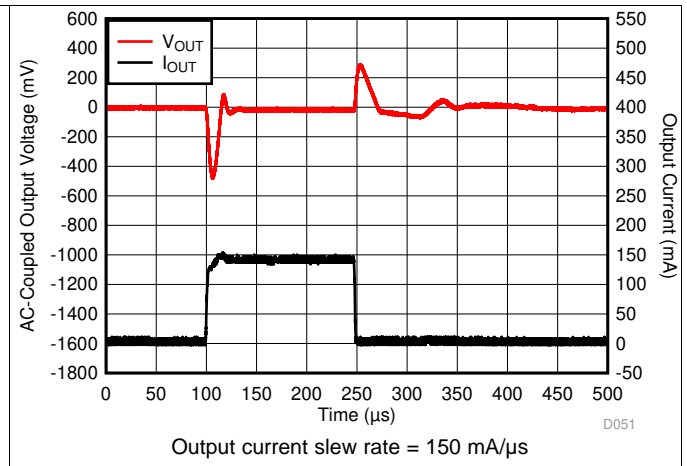


图 14.  $I_{OUT}$  Transient 1 mA to 150 mA

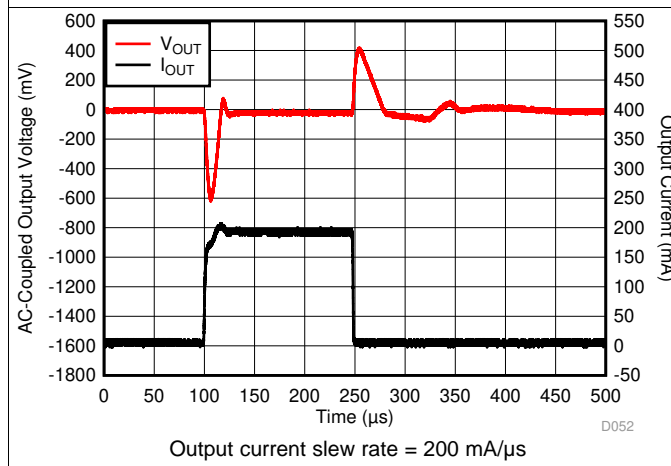


图 15.  $I_{OUT}$  Transient 1 mA to 200 mA

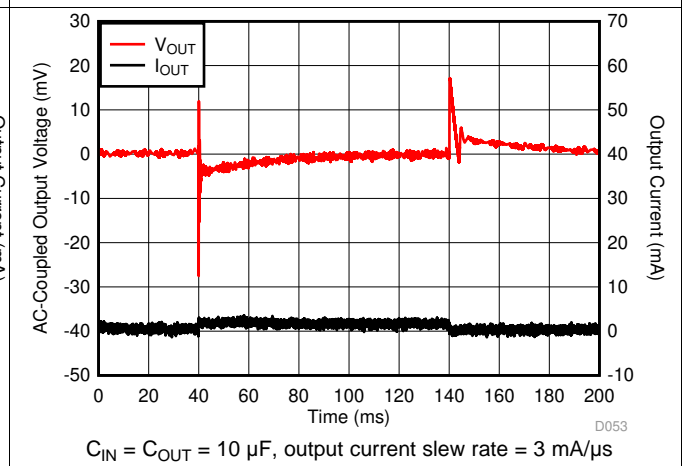


图 16.  $I_{OUT}$  Transient 3  $\mu\text{A}$  to 3 mA

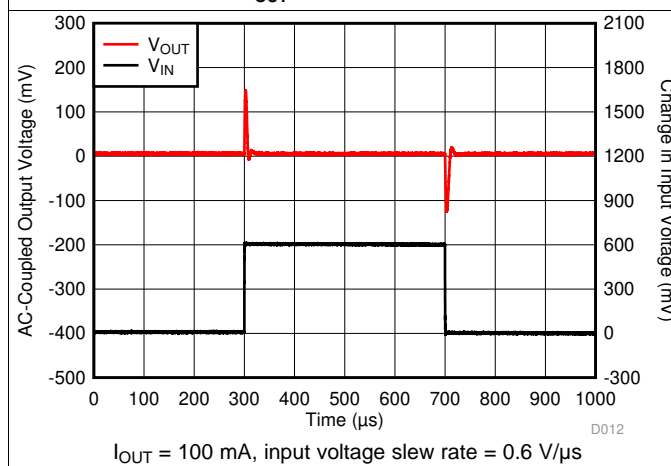


图 17.  $V_{IN}$  Transient

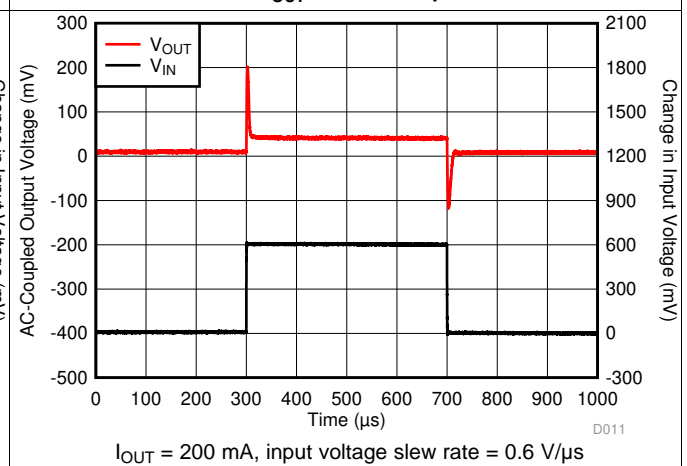


图 18.  $V_{IN}$  Transient

Typical Characteristics (接下页)

at operating temperature  $T_J = 25^\circ\text{C}$ ,  $V_{IN} = V_{OUT(NOM)} + 0.5\text{ V}$  or  $2.0\text{ V}$  (whichever is greater),  $I_{OUT} = 1\text{ mA}$ ,  $V_{EN} = V_{IN}$ ,  $C_{IN} = 1\text{ }\mu\text{F}$ , and  $C_{OUT} = 1\text{ }\mu\text{F}$  (unless otherwise noted)

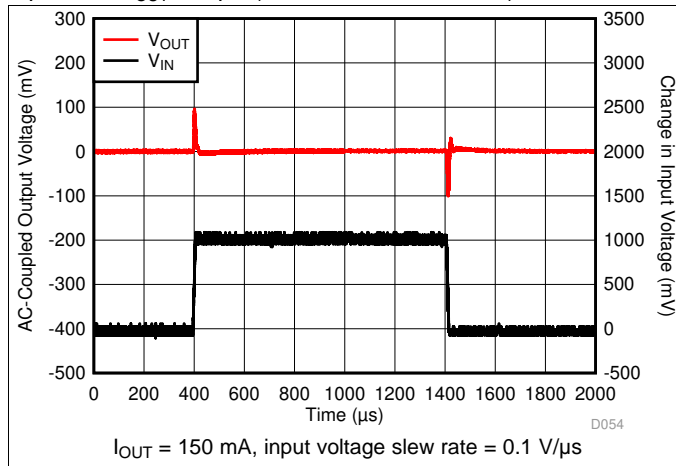


图 19.  $V_{IN}$  Transient

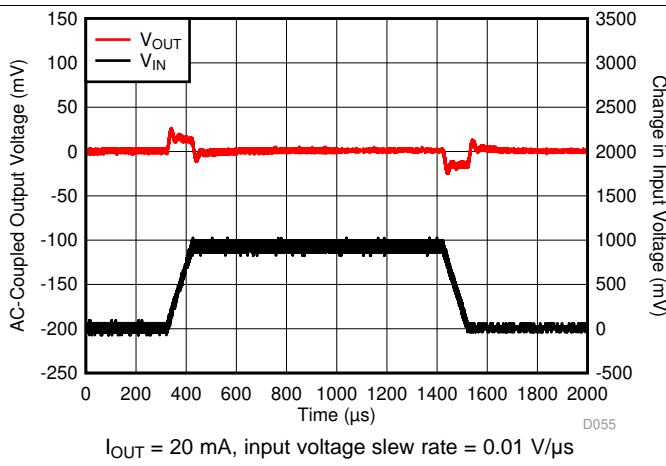


图 20.  $V_{IN}$  Transient

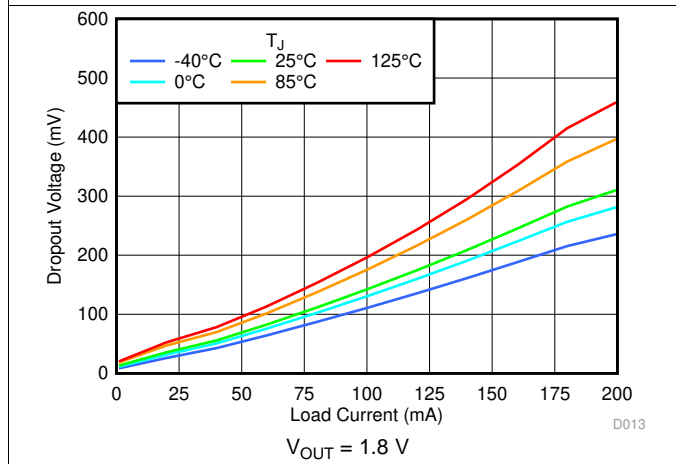


图 21. Dropout vs  $I_{OUT}$  and Temperature

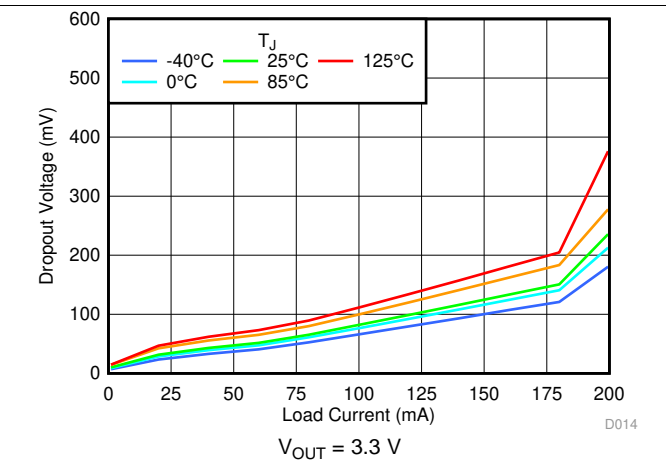


图 22. Dropout vs  $I_{OUT}$  and Temperature

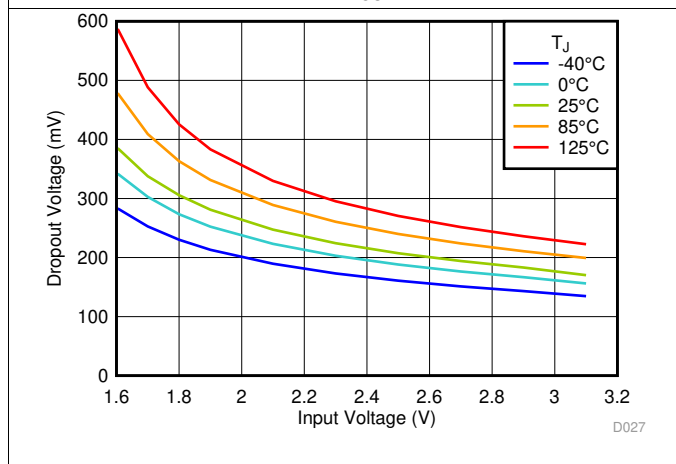


图 23. Dropout vs  $V_{IN}$  and Temperature

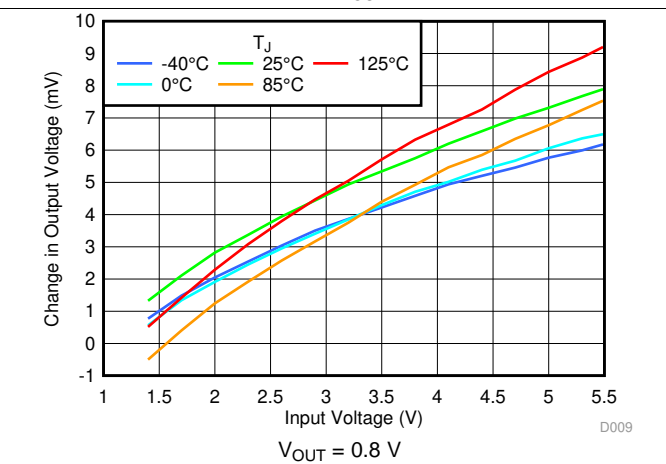


图 24. Line Regulation  $V_{IN}$  and Temperature

Typical Characteristics (接下页)

at operating temperature  $T_J = 25^\circ\text{C}$ ,  $V_{IN} = V_{OUT(NOM)} + 0.5\text{ V}$  or  $2.0\text{ V}$  (whichever is greater),  $I_{OUT} = 1\text{ mA}$ ,  $V_{EN} = V_{IN}$ ,  $C_{IN} = 1\text{ }\mu\text{F}$ , and  $C_{OUT} = 1\text{ }\mu\text{F}$  (unless otherwise noted)

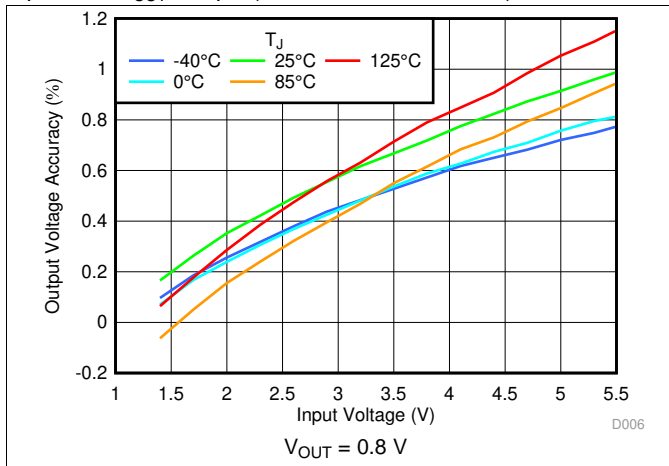


图 25. Output Accuracy  $V_{IN}$  and Temperature

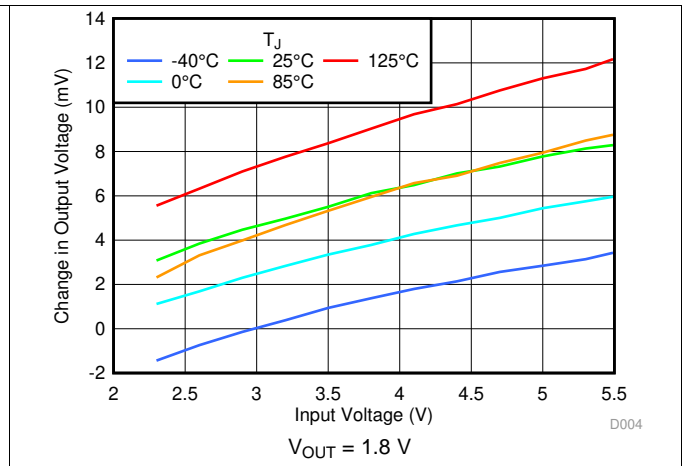


图 26. Line Regulation  $V_{IN}$  and Temperature

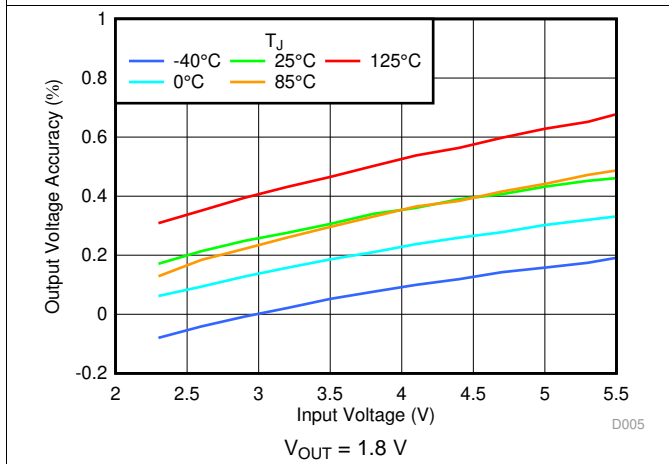


图 27. Output Accuracy  $V_{IN}$  and Temperature

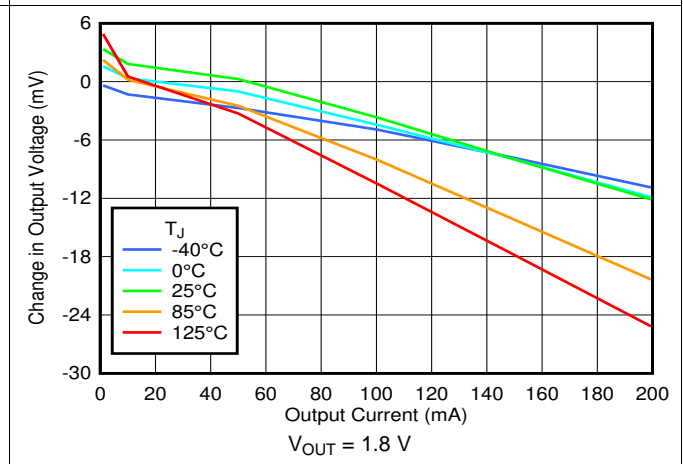


图 28. Load Regulation vs  $I_{OUT}$  and Temperature

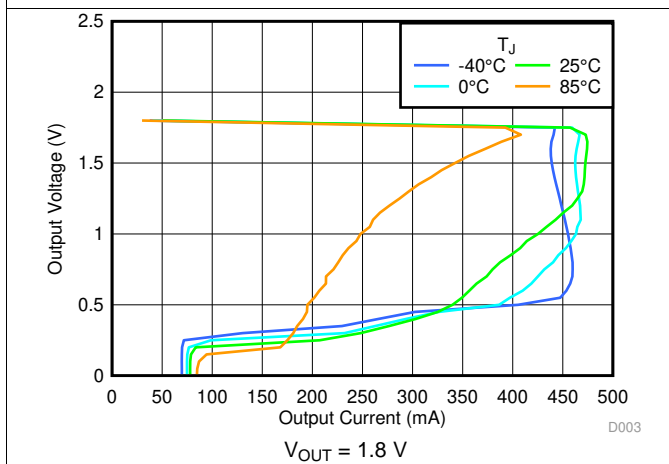


图 29. Foldback Current Limit vs  $I_{OUT}$  and Temperature

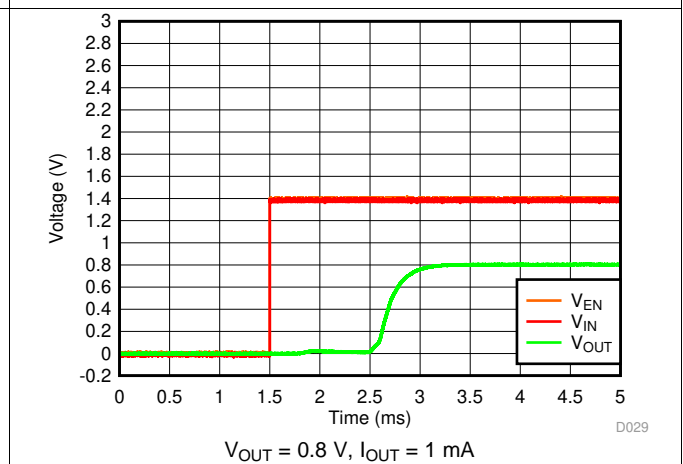
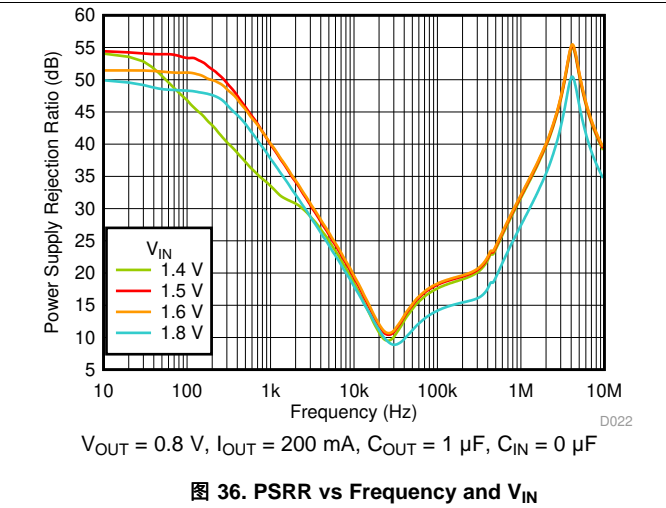
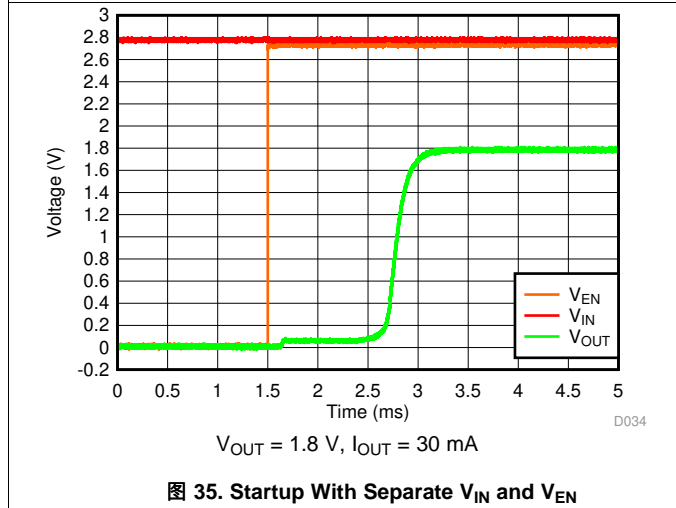
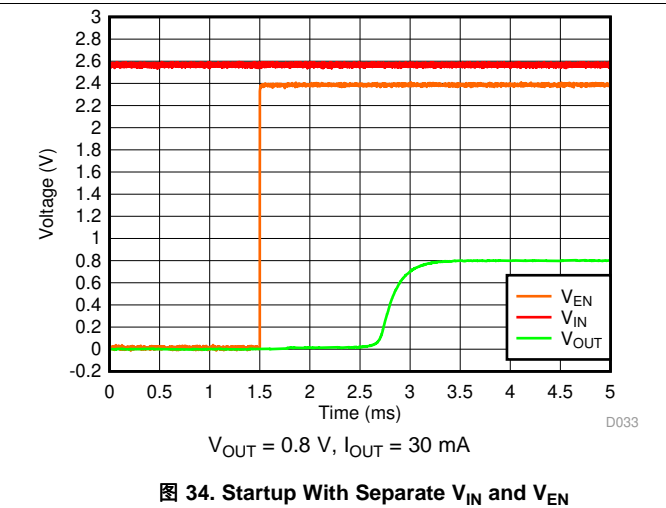
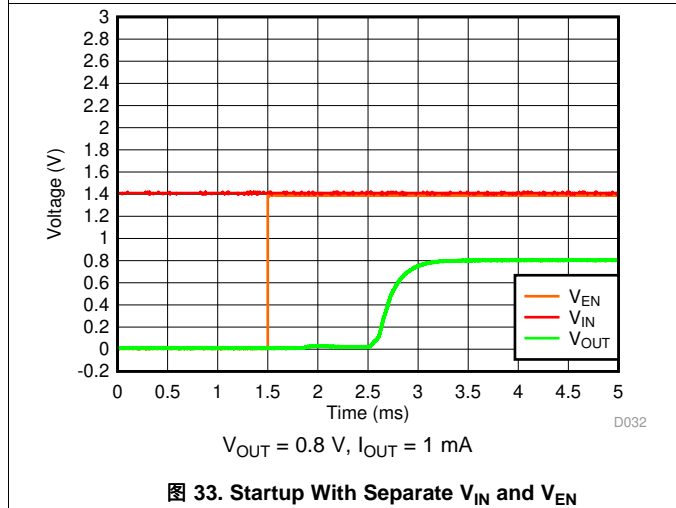
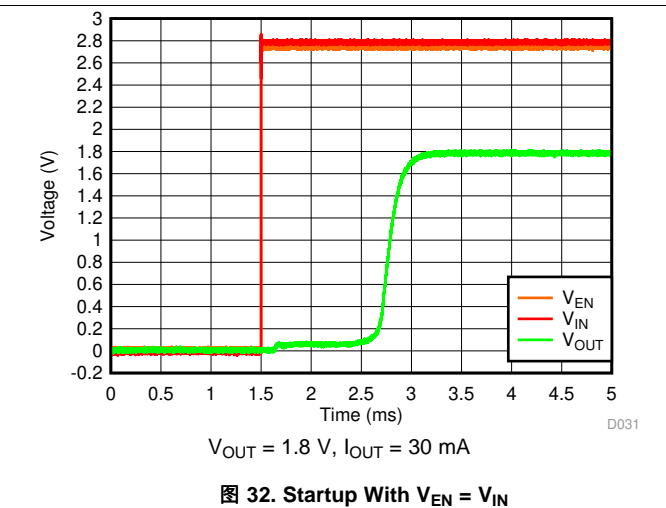
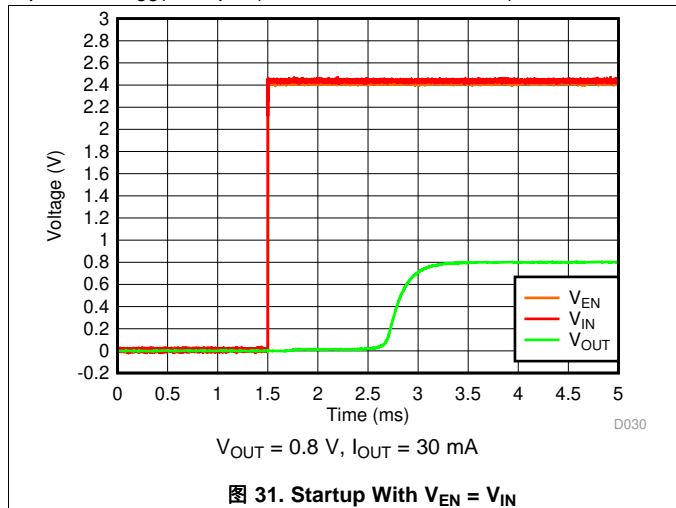


图 30. Startup With  $V_{EN} = V_{IN}$

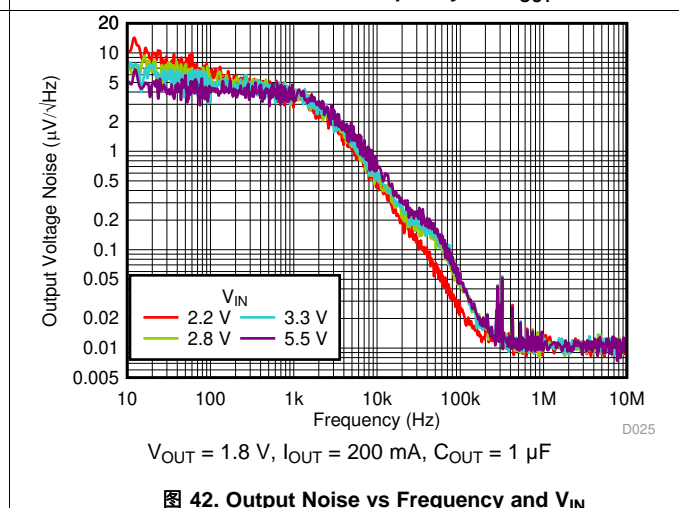
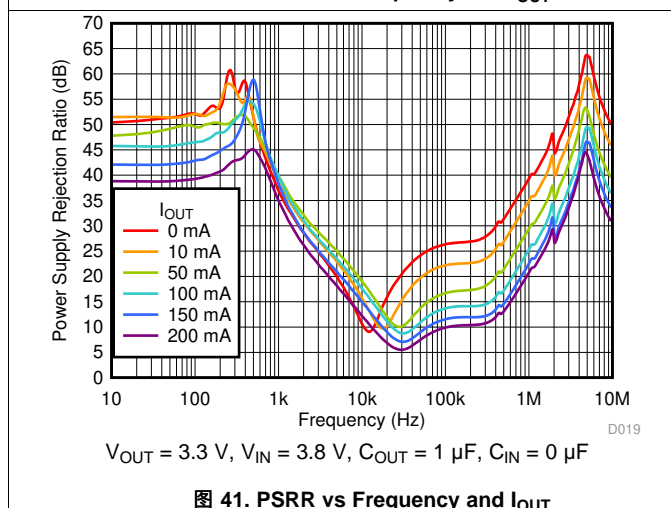
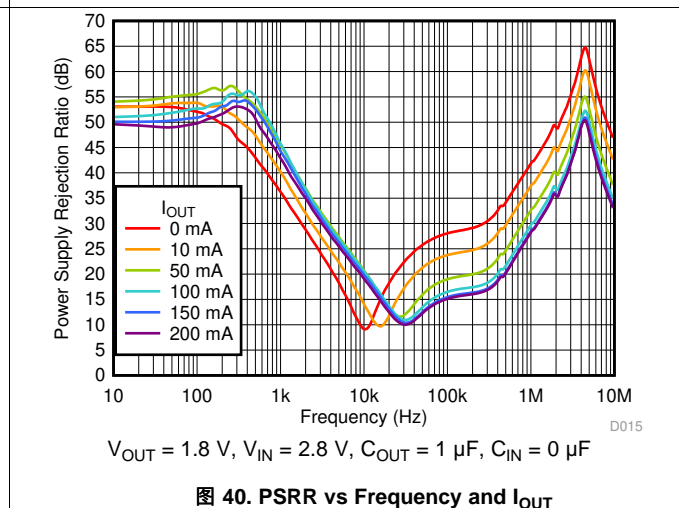
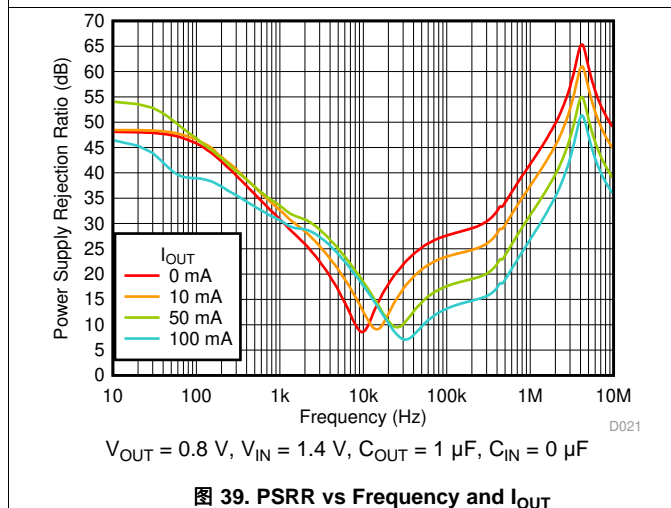
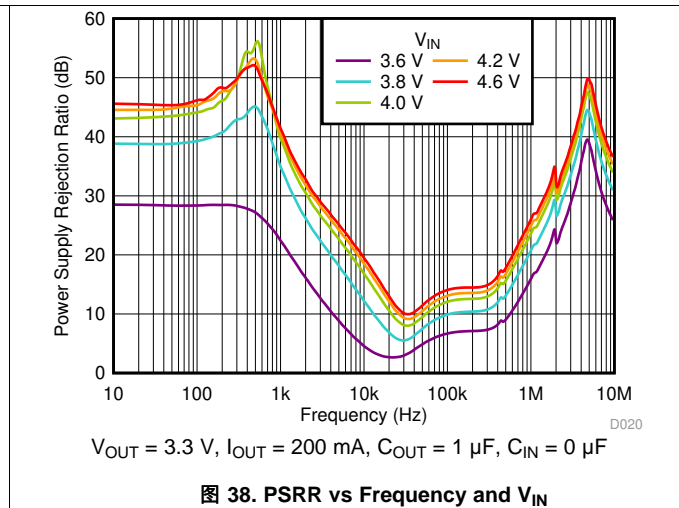
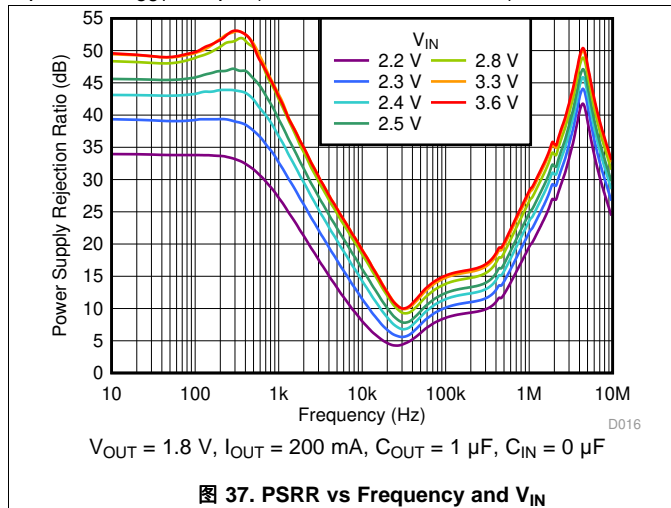
Typical Characteristics (接下页)

at operating temperature  $T_J = 25^\circ\text{C}$ ,  $V_{IN} = V_{OUT(NOM)} + 0.5\text{ V}$  or  $2.0\text{ V}$  (whichever is greater),  $I_{OUT} = 1\text{ mA}$ ,  $V_{EN} = V_{IN}$ ,  $C_{IN} = 1\ \mu\text{F}$ , and  $C_{OUT} = 1\ \mu\text{F}$  (unless otherwise noted)



Typical Characteristics (接下页)

at operating temperature  $T_J = 25^\circ\text{C}$ ,  $V_{IN} = V_{OUT(NOM)} + 0.5\text{ V}$  or  $2.0\text{ V}$  (whichever is greater),  $I_{OUT} = 1\text{ mA}$ ,  $V_{EN} = V_{IN}$ ,  $C_{IN} = 1\text{ }\mu\text{F}$ , and  $C_{OUT} = 1\text{ }\mu\text{F}$  (unless otherwise noted)





Typical Characteristics (接下页)

at operating temperature  $T_J = 25^\circ\text{C}$ ,  $V_{IN} = V_{OUT(NOM)} + 0.5\text{ V}$  or  $2.0\text{ V}$  (whichever is greater),  $I_{OUT} = 1\text{ mA}$ ,  $V_{EN} = V_{IN}$ ,  $C_{IN} = 1\text{ }\mu\text{F}$ , and  $C_{OUT} = 1\text{ }\mu\text{F}$  (unless otherwise noted)

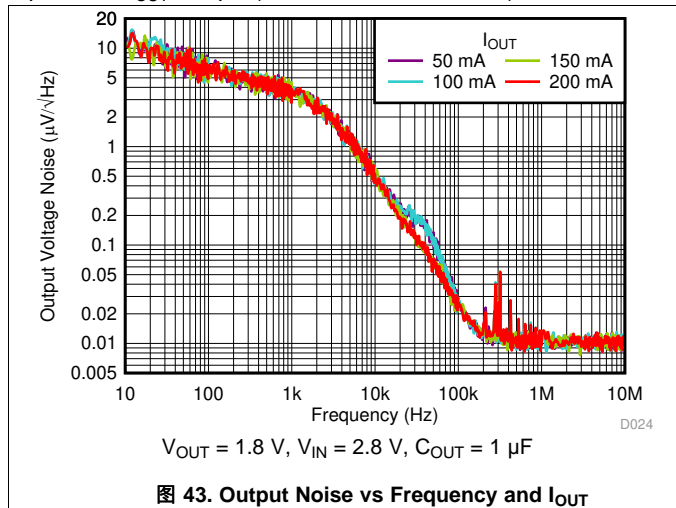


图 43. Output Noise vs Frequency and  $I_{OUT}$

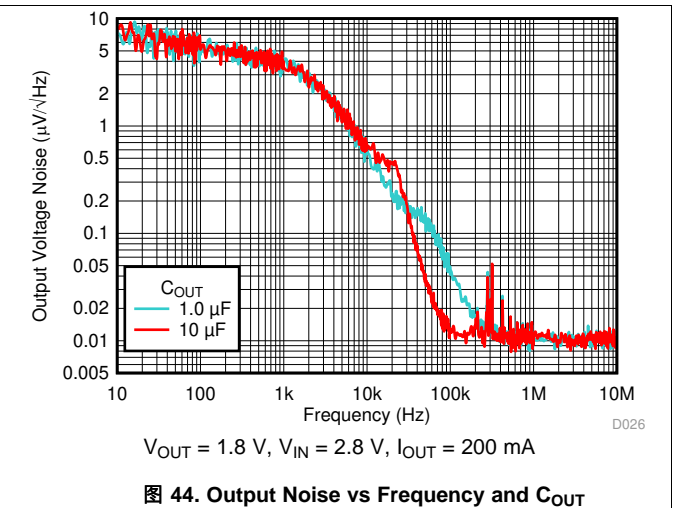


图 44. Output Noise vs Frequency and  $C_{OUT}$

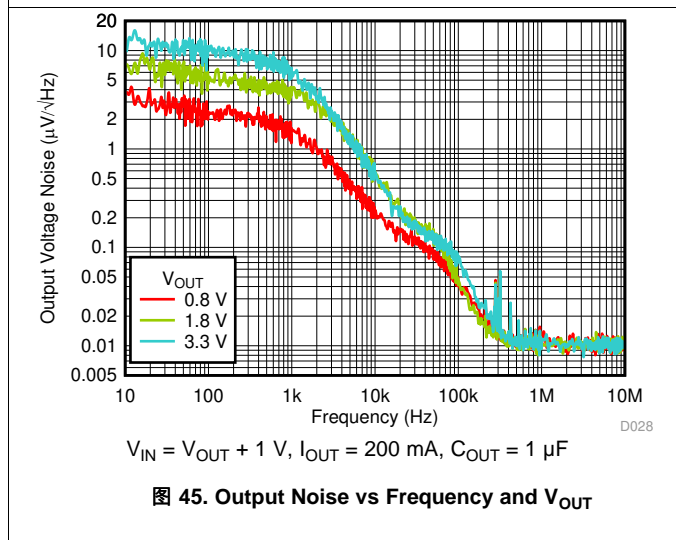


图 45. Output Noise vs Frequency and  $V_{OUT}$

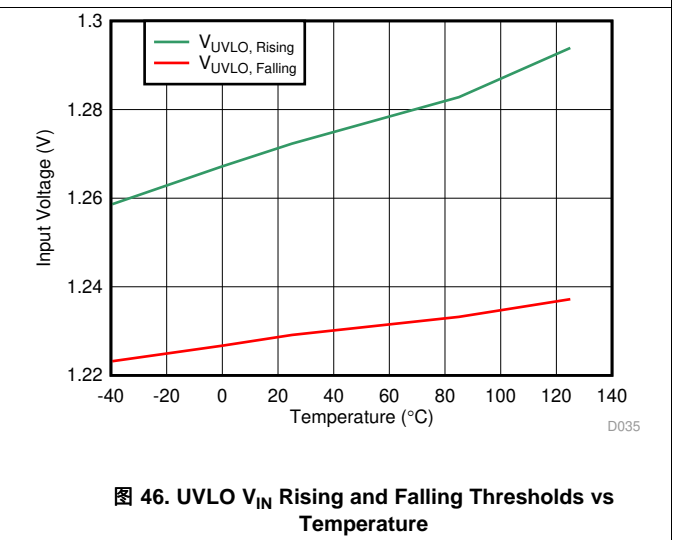


图 46. UVLO  $V_{IN}$  Rising and Falling Thresholds vs Temperature

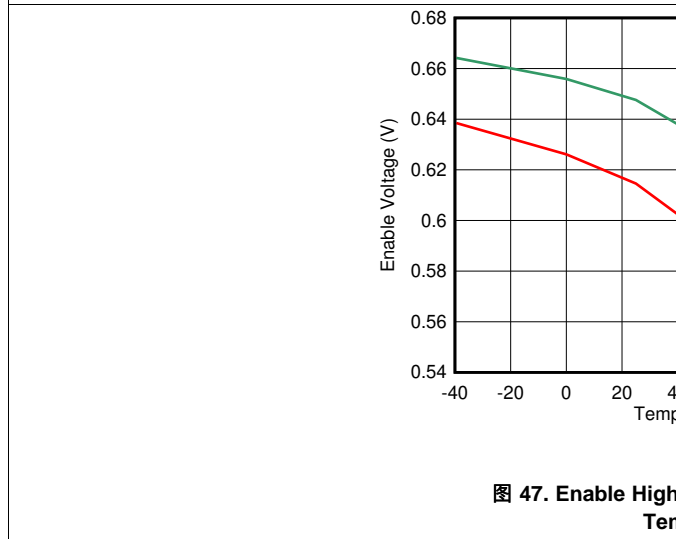


图 47. Enable High and Low Thresholds vs Temperature

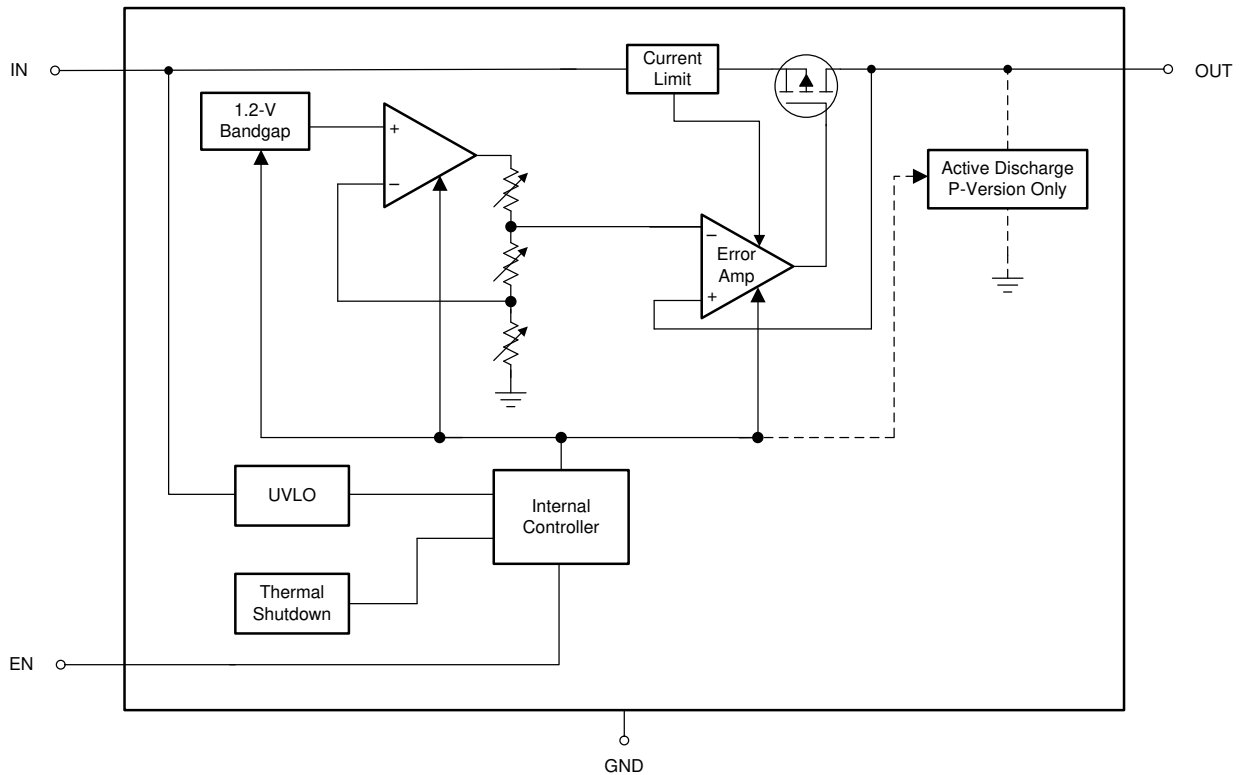
## 7 Detailed Description

### 7.1 Overview

The TPS7A05 is a ultra-low  $I_Q$  linear voltage regulator that is optimized for excellent transient performance. These characteristics make the TPS7A05 ideal for most battery-powered applications.

This low-dropout regulator (LDO) offers foldback current limit, shutdown, thermal protection, and optional active discharge.

### 7.2 Functional Block Diagram



## 7.3 Feature Description

### 7.3.1 Excellent Transient Response

The device includes several innovative circuits to ensure excellent transient response. Dynamic biasing increases the  $I_Q$  for a short duration during transients to extend the closed-loop bandwidth and improve the device response time during transients.

Adaptive biasing increases the  $I_Q$  as the dc load current increases, extending the bandwidth of the control loop. The device response time across the output voltage range is constant because of the use of a buffered reference topology, which keeps the control loop in unity gain at any output voltage.

These features give the device a wide loop bandwidth during transients that ensure excellent transient response while maintaining the device low  $I_Q$  in steady-state conditions; see the [Application and Implementation](#) section for more details.

### 7.3.2 Active Discharge

Devices with this option have an internal pulldown MOSFET that connects a 120- $\Omega$  resistor to ground when the device is disabled to actively discharge the output voltage. The active discharge circuit is activated when the device is disabled, in undervoltage lockout (UVLO), or in thermal shutdown.

The discharge time after disabling depends on the output capacitance ( $C_{OUT}$ ) and the load resistance ( $R_L$ ) in parallel with the 120- $\Omega$  pulldown resistor. [公式 1](#) calculates the time constant:

$$\tau = \frac{120 \cdot R_L}{120 + R_L} \cdot C_{OUT} \quad (1)$$

Do not rely on the active discharge circuit for discharging a large amount of output capacitance after the input supply has collapsed because reverse current can flow from the output to the input. This reverse current flow can cause damage to the device. Limit reverse current to no more than 5% of the device-rated current.

### 7.3.3 Low $I_Q$ in Dropout

In most LDOs the  $I_Q$  significantly increases when the device is placed into dropout, which is especially true for low  $I_Q$  LDOs with adaptive biasing. The TPS7A05 detects when operating in dropout and disables the adaptive biasing, minimizing the  $I_Q$  increase.

### 7.3.4 Undervoltage Lockout (UVLO)

The undervoltage lockout (UVLO) circuit monitors the input voltage ( $V_{IN}$ ) to prevent the device from turning on before  $V_{IN}$  rises above the lockout voltage. The UVLO circuit also disables the output of the device when  $V_{IN}$  falls below the lockout voltage. If the device includes the optional active discharge, the output is connected to ground with a 120- $\Omega$  pulldown resistor when  $V_{IN}$  is below the lockout voltage; see the [Application and Implementation](#) section for more details.

### 7.3.5 Enable

The enable pin for the device is active high. The output of the device is turned on when the enable pin voltage is greater than the EN pin logic high voltage, and the output of the device is turned off when the enable pin voltage is less than the EN pin logic low voltage. A voltage less than the EN pin logic low voltage on the enable pin disables all internal circuits.

At the next turn-on, any voltage on the EN pin below the logic low voltage ensures a normal start-up waveform with start-up ramp rate control, provided there is enough time to discharge the output capacitance. If shutdown capability is not required, connect EN to IN.  $V_{EN}$  must not exceed  $V_{IN}$ .

### 7.3.6 Internal Foldback Current Limit

The internal foldback current-limit circuit is used to protect the LDO against high-load current faults or shorting events. The foldback mechanism lowers the current limit as the output voltage decreases, and limits power dissipation during short-circuit events while still allowing for the device to operate at its rated output current; see [图 29](#).

## Feature Description (接下页)

A foldback example for this device is that when  $V_{OUT}$  is 90% of  $V_{OUT(nom)}$  the current limit is  $I_{CL}(\text{typical})$ ; however, if  $V_{OUT}$  is forced to 0 V the current limit is  $I_{SC}(\text{typical})$ .

In many LDOs the foldback current limit can prevent start-up into a constant-current load or a negatively-biased output. The foldback mechanism for this device goes into a brick-wall current limit when  $V_{OUT} > 500$  mV (typ), thus limiting current to  $I_{CL}(\text{typical})$  and, when  $V_{OUT}$  is approximately 0 V, current is limited to  $I_{SC}(\text{typical})$  to ensure normal start-up into a variety of loads.

The foldback current limit is disengaged when  $I_{OUT} < 1$  mA (typical) to reduce  $I_Q$ . As such, the current-limit loop takes longer to respond to a current-limit event when  $I_{OUT} < 1$  mA (typ).

Thermal shutdown can activate during a current-limit event because of the high power dissipation typically found in these conditions. To ensure proper operation of the current limit, minimize the inductances to the input and load. Continuous operation in current limit is not recommended.

### 7.3.7 Thermal Shutdown

The device contains a thermal shutdown protection circuit to disable the device when thermal junction temperature ( $T_J$ ) of the main pass-FET rises to  $T_{sd(\text{Shutdown})}$  (typical). Thermal shutdown hysteresis assures that the LDO resets again (turns on) when the temperature falls to  $T_{sd(\text{Reset})}$  (typical).

The thermal time-constant of the semiconductor die is fairly short, and thus the device may cycle on and off when thermal shutdown is reached until power dissipation is reduced.

For reliable operation, limit the junction temperature to a maximum of 125°C. Operation above 125°C causes the device to exceed its operational specifications. Although the internal protection circuitry of the device is designed to protect against thermal overload conditions, this circuitry is not intended to replace proper heat sinking. Continuously running the device into thermal shutdown or above a junction temperature of 125°C reduces long-term reliability.

A fast start-up when  $T_J > T_{sd(\text{Reset})}$  (typical, outside of the specified operating range) causes the device thermal shutdown to assert at  $T_{sd(\text{Reset})}$  and prevents the device from turning on until the junction temperature is reduced below  $T_{sd(\text{Shutdown})}$ .

## 7.4 Device Functional Modes

The device has several modes of operation,:

- Normal operation: The device regulates to the nominal output voltage
- Dropout operation: The pass element operates as a resistor and the output voltage is set as  $V_{IN} - V_{DO}$
- Shutdown: The output of the device is disabled and the discharge circuit is activated

表 1 shows the conditions that lead to the different modes of operation. See the [Electrical Characteristics](#) table for parameter values.

**表 1. Device Functional Mode Comparison**

| OPERATING MODE   | PARAMETER   |                       |                          |                          |
|--|---|-----------------------|--------------------------|--------------------------|
|  | $V_{IN}$  | $V_{EN}$              | $I_{OUT}$                | $T_J$                    |
| Normal mode  | $V_{IN} > V_{OUT(nom)} + V_{DO}$ and $V_{IN} > V_{IN(min)}$ | $V_{EN} > V_{EN(HI)}$ | $I_{OUT} < I_{OUT(max)}$ | $T_J < T_{sd(Shutdown)}$ |
| Dropout mode   | $V_{IN(min)} < V_{IN} < V_{OUT(nom)} + V_{DO}$              | $V_{EN} > V_{EN(HI)}$ | $I_{OUT} < I_{OUT(max)}$ | $T_J < T_{sd(Shutdown)}$ |
| Disabled mode<br>(any true condition<br>disables the device) | $V_{IN} < V_{UVLO}$   | $V_{EN} < V_{EN(LO)}$ | —                        | $T_J > T_{sd(Shutdown)}$ |

### 7.4.1 Normal Mode

The device regulates the output to the nominal output voltage when all normal mode conditions in 表 1 are met.

### 7.4.2 Dropout Mode

The device is not in regulation, and the output voltage tracks the input voltage minus the voltage drop across the pass transistor of the device. In this mode, the PSRR, noise, and transient performance of the device are significantly degraded.

### 7.4.3 Disable Mode

In this mode, the pass element is turned off, the internal circuits are shut down, and the output voltage is actively discharged to ground by an internal resistor.

## 8 Application and Implementation

### 注

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 8.1 Application Information

#### 8.1.1 Recommended Capacitor Types

The device is designed to be stable using low equivalent series resistance (ESR) ceramic capacitors at the input and output. Multilayer ceramic capacitors have become the industry standard for these types of applications and are recommended, but must be used with good judgment. Ceramic capacitors that employ X7R-, X5R-, and COG-rated dielectric materials provide relatively good capacitive stability across temperature, whereas the use of Y5V-rated capacitors is discouraged because of large variations in capacitance.

Regardless of the ceramic capacitor type selected, the effective capacitance varies with operating voltage and temperature. As a rule of thumb, assume effective capacitance to decrease by as much as 50%. The input and output capacitors recommended in the [Recommended Operating Conditions](#) table account for an effective capacitance of approximately 50% of the nominal value.

#### 8.1.2 Input and Output Capacitor Requirements

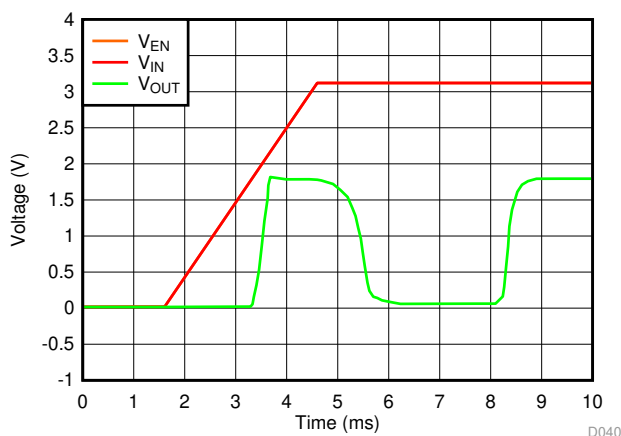
Although an input capacitor is not required for stability, good analog design practice is to connect a capacitor from IN to GND. This capacitor counteracts reactive input sources and improves transient response, input ripple, and PSRR. An input capacitor is recommended if the source impedance is more than  $0.5 \Omega$ . A higher value capacitor may be necessary if large, fast rise-time load or line transients are anticipated or if the device is located several inches from the input power source.

Dynamic performance of the device is improved with the use of an output capacitor. Use an output capacitor within the range specified in the [Recommended Operating Conditions](#) table for stability.

#### 8.1.3 Special Considerations When Ramping Down $V_{IN}$ and Enable

Care must be taken when ramping down voltage on the IN and EN pins to power-down the device when the operating free-air temperature is less than  $15^{\circ}\text{C}$ . The minimum ramp-down time for the IN pin is 10 ms. The minimum ramp-down time for the EN pin is 100  $\mu\text{s}$ . Ramping at faster rates can cause the regulator to exhibit undesired startup behavior on the next power-on.

If  $V_{IN}$  is ramped down faster than 10 ms, the next startup may exhibit a partial startup, shutdown, followed by a normal soft-start startup. [图 48](#) shows this response.



**图 48. Partial Startup, Shutdown, Normal Startup With  $V_{EN} = V_{IN}$**

## Application Information (接下页)

If the EN pin is ramped down faster than 100  $\mu$ s, the next startup may exhibit a delay time of up to 130 ms before the output ramps up with a normal soft-start startup. 图 49 shows this delay.

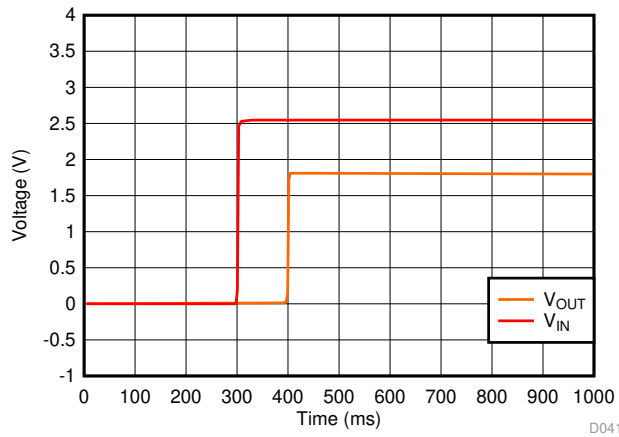


图 49. Long Delay to Startup With  $V_{EN} = V_{IN}$

Fast ramp downs of  $V_{IN}$  and the EN pin charge internal high-impedance nodes in the device, which take extended time to discharge below 15°C. To avoid these startup behaviors, follow the recommended minimum ramp down times for  $V_{IN}$  and the EN pin.

### 8.1.4 Load Transient Response

The load-step transient response is the output voltage response by the LDO to a step in load current, whereby output voltage regulation is maintained. See 图 6 for typical load transient response. There are two key transitions during a load transient response: the transition from a light to a heavy load and the transition from a heavy to a light load. The regions in 图 50 are broken down as described in this section. Regions A, E, and H are where the output voltage is in steady-state.

During transitions from a light load to a heavy load, the:

- Initial voltage dip is a result of the depletion of the output capacitor charge and parasitic impedance to the output capacitor (region B)
- Recovery from the dip results from the LDO increasing its sourcing current, and leads to output voltage regulation (region C)

During transitions from a heavy load to a light load, the:

- Initial voltage rise results from the LDO sourcing a large current, and leads to the output capacitor charge to increase (region F)
- Recovery from the rise results from the LDO decreasing its sourcing current in combination with the load discharging the output capacitor (region G)

A larger output capacitance reduces the peaks during a load transient but slows down the response time of the device. A larger dc load also reduces the peaks because the amplitude of the transition is lowered and a higher current discharge path is provided for the output capacitor.

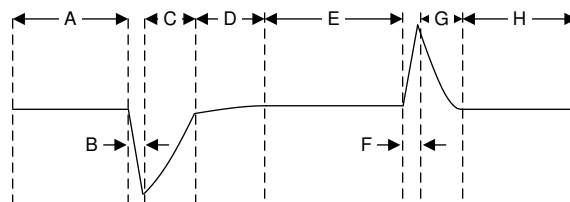


图 50. Load Transient Waveform

## Application Information (接下页)

### 8.1.5 Dropout Voltage

The device uses a PMOS pass transistor to achieve low dropout. When  $(V_{IN} - V_{OUT})$  is less than the dropout voltage ( $V_{DO}$ ), the PMOS pass transistor is in the linear region of operation, and the input-to-output resistance of the device is the drain-to-source resistance of the PMOS pass transistor.  $V_{DO}$  scales with the output current and changes with temperature because the PMOS pass transistor functions like a resistor in dropout mode. For a graph of dropout voltage, see [图 22](#). As with any linear regulator, PSRR and the transient response degrade as  $(V_{IN} - V_{OUT})$  approaches dropout operation. See [图 23](#) for dropout performance.

#### 8.1.5.1 Behavior When Transitioning From Dropout Into Regulation

Some applications may have transients that place the device into dropout, especially as this device can be powered from a battery with high ESR. A typical application with these conditions is using a stack of two 1.55-V coin-cell batteries with an ESR of  $30\ \Omega$  to create a 2.5-V rail and experiencing a load transient from 1  $\mu$ A to 25 mA. This load transient causes the input supply to drop 750 mV, placing the device into dropout.

The load transient saturates the output stage of the error amplifier when the pass element is driven fully on, making the pass element function like a resistor from  $V_{IN}$  to  $V_{OUT}$ . The error amplifier response time to this load transient is limited because the error amplifier must first recover from saturation and then place the pass element back into active mode. During this time  $V_{OUT}$  overshoots because the pass element is functioning as a resistor from  $V_{IN}$  to  $V_{OUT}$ . This device uses a loop pulldown circuit to help mitigate the overshoot.

If operating under these conditions, applying a higher dc load or increasing the output capacitance reduces the overshoot because these solutions provide a path to dissipate the excess charge.

#### 8.1.5.2 Behavior of Output Resulting From Line Transient When in Dropout

The output deviation resulting from a line transient can be significantly higher when the device is operating in dropout. As explained in the [Dropout Voltage](#) section, the response time of the error amplifier is limited when in dropout, so the output deviation is larger and can exceed twice the regulated output voltage. Care must be taken in applications where line transients are expected when the device is operating in dropout.

### 8.1.6 Undervoltage Lockout (UVLO) Operation

The UVLO circuit ensures that the device stays disabled before its input supply reaches the minimum operational voltage range, and ensures that the device shuts down when the input supply collapses. See [图 46](#) for rising and falling thresholds. [图 51](#) depicts the UVLO circuit response to various input voltage events. The diagram can be separated into the following parts:

- Region A: The device does not start until the input reaches the UVLO rising threshold
- Region B: Normal operation, regulating device
- Region C: Brownout event above the UVLO falling threshold (UVLO rising threshold – UVLO hysteresis). The output may fall out of regulation but the device is still enabled.
- Region D: Normal operation, regulating device
- Region E: Brownout event below the UVLO falling threshold. The device is disabled in most cases and the output falls as a result of the load and active discharge circuit. The device is re-enabled when the UVLO rising threshold is reached by the input voltage and a normal start-up follows.
- Region F: Normal operation followed by the input falling to the UVLO falling threshold
- Region G: The device is disabled as the input voltage falls below the UVLO falling threshold to 0 V. The output falls as a result of the load and active discharge circuit.



## Application Information (接下页)

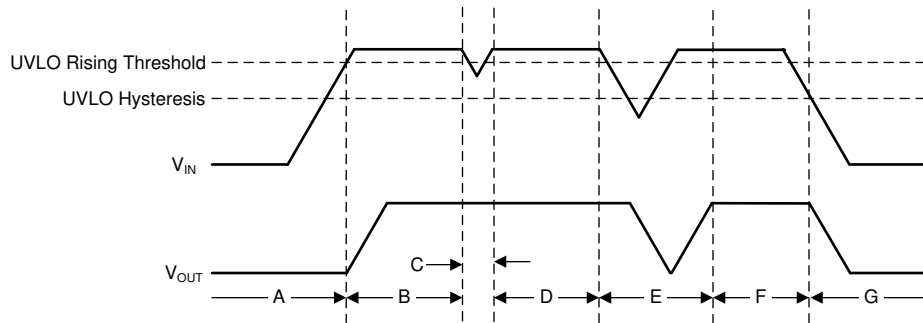


图 51. Typical UVLO Operation

### 8.1.7 Power Dissipation ( $P_D$ )

Circuit reliability demands that proper consideration be given to device power dissipation, location of the circuit on the printed circuit board (PCB), and correct sizing of the thermal plane. The PCB area around the regulator must be as free as possible of other heat-generating devices that cause added thermal stresses.

公式 2 calculates the maximum allowable power dissipation for the device in a given package:

$$P_{D-MAX} = (T_J - T_A) / R_{\theta JA} \quad (2)$$

公式 3 represents the actual power being dissipated in the device:

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} \quad (3)$$

An important note is that power dissipation can be minimized, and thus greater efficiency achieved, by proper selection of the system voltage rails. Proper selection allows the minimum input-to-output voltage differential to be obtained. The low dropout of the TPS7A05 allows for maximum efficiency across a wide range of output voltages.

The main heat conduction path for the device depends on the ambient temperature and the thermal resistance across the various interfaces between the die junction and ambient air.

The maximum power dissipation determines the maximum allowable junction temperature ( $T_J$ ) for the device. According to 公式 4, maximum power dissipation and junction temperature are most often related by the junction-to-ambient thermal resistance ( $R_{\theta JA}$ ) of the combined PCB and device package and the temperature of the ambient air ( $T_A$ ). The equation is rearranged in 公式 5 for output current.

$$T_J = T_A + (R_{\theta JA} \times P_D) \quad (4)$$

$$I_{OUT} = (T_J - T_A) / [R_{\theta JA} \times (V_{IN} - V_{OUT})] \quad (5)$$

Unfortunately, this thermal resistance ( $R_{\theta JA}$ ) is highly dependent on the heat-spreading capability built into the particular PCB design, and therefore varies according to the total copper area, copper weight, and location of the planes. The  $R_{\theta JA}$  recorded in the [Thermal Information](#) table is determined by the JEDEC standard, PCB, and copper-spreading area, and is only used as a relative measure of package thermal performance. For a well-designed thermal layout,  $R_{\theta JA}$  is actually the sum of the DQN package junction-to-case (bottom) thermal resistance ( $R_{\theta JC(bot)}$ ) plus the thermal resistance contribution by the PCB copper.

## Application Information (接下页)

### 8.1.7.1 Estimating Junction Temperature

The JEDEC standard now recommends the use of psi ( $\Psi$ ) thermal metrics to estimate the junction temperatures of the LDO when in-circuit on a typical PCB board application. These metrics are not strictly speaking thermal resistances, but rather offer practical and relative means of estimating junction temperatures. These psi metrics are determined to be significantly independent of the copper-spreading area. The key thermal metrics ( $\Psi_{JT}$  and  $\Psi_{JB}$ ) are used in accordance with 公式 6 and are given in the [Thermal Information](#) table.

$$\Psi_{JT} : T_J = T_T + \Psi_{JT} \times P_D \text{ and } \Psi_{JB} : T_J = T_B + \Psi_{JB} \times P_D$$

where:

- $P_D$  is the power dissipated as explained in 公式 3
  - $T_T$  is the temperature at the center-top of the device package, and
  - $T_B$  is the PCB surface temperature measured 1 mm from the device package and centered on the package edge
- (6)

### 8.1.7.2 Recommended Area for Continuous Operation

The operational area of an LDO is limited by the dropout voltage, output current, junction temperature, and input voltage. The recommended area for continuous operation for a linear regulator is shown in 图 52 and can be separated into the following regions:

- Dropout voltage limits the minimum differential voltage between the input and the output ( $V_{IN} - V_{OUT}$ ) at a given output current level; see the [Dropout Voltage](#) section for more details.
- The rated output currents limits the maximum recommended output current level. Exceeding this rating causes the device to fall out of specification.
- The rated junction temperature limits the maximum junction temperature of the device. Exceeding this rating causes the device to fall out of specification and reduces long-term reliability.
  - 公式 5 provides the shape of the slope. The slope is nonlinear because the maximum rated junction temperature of the LDO is controlled by the power dissipation across the LDO, thus when  $V_{IN} - V_{OUT}$  increases the output current must decrease.
- The rated input voltage range governs both the minimum and maximum of  $V_{IN} - V_{OUT}$ .

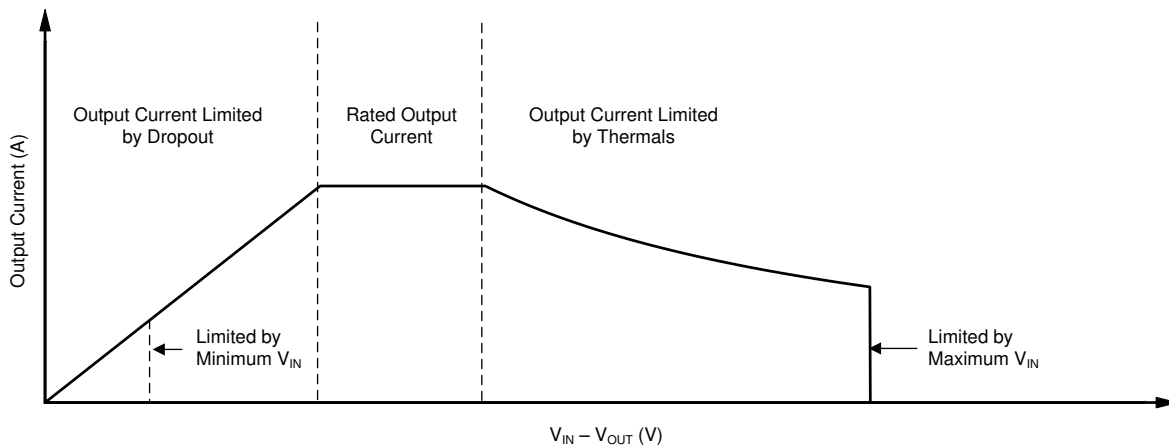


图 52. Region Description for Continuous Operation

## 8.2 Typical Application

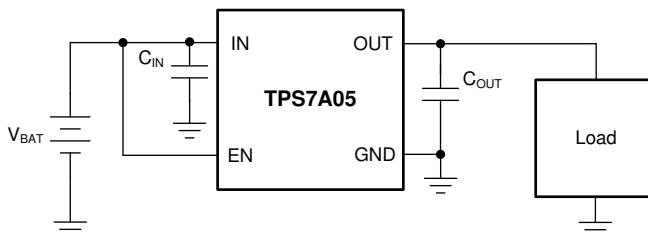


图 53. Operation From the Battery Input Supply

### 8.2.1 Design Requirements

表 2 summarizes the design requirements for 图 53.

表 2. Design Parameters

| PARAMETER      | DESIGN REQUIREMENT   |
|----------------|--|
| Input voltage  | 3.0 V to 2.0 V (CR2032 battery)                              |
| Output voltage | 1.0 V, $\pm 2\%$ ( $T_J$ from $-40$ to $+85^\circ\text{C}$ ) |
| Output load    | 10 mA  |

### 8.2.2 Design Considerations

For this design example, the 1.0-V, fixed-version TPS7A0510 device is selected. A single CR2032 coin-cell battery was used, thus a 1.0- $\mu\text{F}$  input capacitor is recommended to minimize transient currents drawn from the battery. A 1.0- $\mu\text{F}$  output capacitor is also recommended for excellent load transient response. The dropout voltage ( $V_{DO}$ ) is kept within the TPS7A05 dropout voltage specification for the 1.0-V output voltage option to keep the device in regulation under all load and temperature conditions for this design. The very small ground current consumed by the regulator shown in 图 54 allows for long battery life.

### 8.2.3 Application Curve

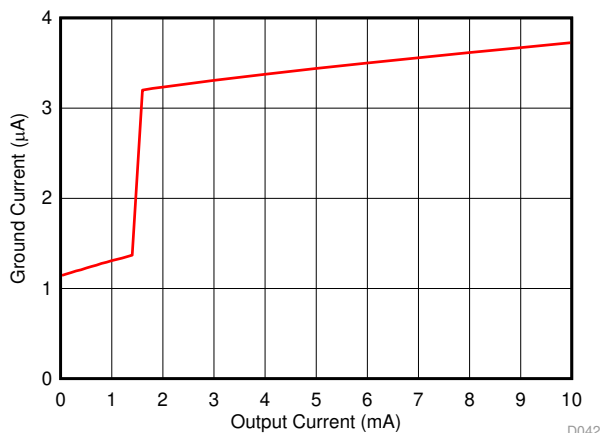


图 54.  $I_{GND}$  vs  $I_{OUT}$  at 25°C

## 9 Power Supply Recommendations

This device is designed to operate from an input supply voltage range of 1.4 V to 5.5 V. The input supply must be well regulated and free of spurious noise. To ensure that the output voltage is well regulated and dynamic performance is optimum, the input supply must be at least  $V_{OUT(nom)} + 0.5$  V. A 1  $\mu\text{F}$  or greater input capacitor is recommended to be used to reduce the impedance of the input supply, especially during transients.

## 10 Layout

### 10.1 Layout Guidelines

- Place input and output capacitors as close to the device as possible
- Use copper planes for device connections to optimize thermal performance
- Place thermal vias around the device to distribute heat
- Do not place a thermal via directly beneath the thermal pad of the DQN package. A via can wick solder or solder paste away from the thermal pad joint during the soldering process, leading to a compromised solder joint on the thermal pad.

### 10.2 Layout Example

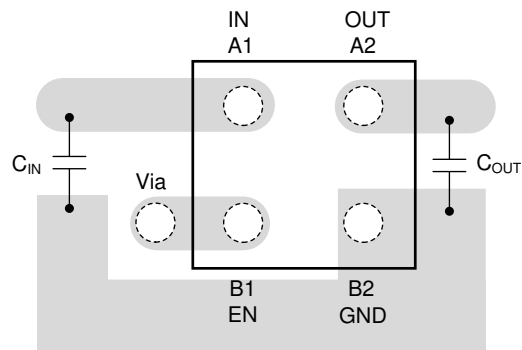


图 55. Layout Example for the YKA Package

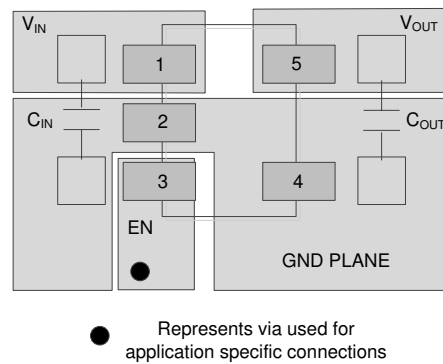


图 56. Layout Example for the DBV Package

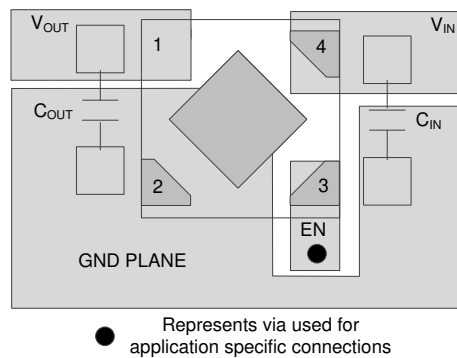


图 57. Layout Example for the DQN Package

## 11 器件和文档支持

### 11.1 器件支持

#### 11.1.1 Spice 模型

您可以从 [产品文件夹](#) 中的工具与软件下获取 TPS7A05 的 SPICE 模型。

#### 11.1.2 器件命名规则

表 3. 器件命名规则<sup>(1)(2)</sup>

| 产品                | V <sub>OUT</sub>   |
|-------------------|--|
| TPS7A05xx(x)Pyyyz | <p><b>xx(x)</b> 为标称输出电压。对于分辨率为 100mV 的输出电压，订货编号中使用两位数字；否则，使用三位数字（例如，28 = 2.8V；125 = 1.25V）。</p> <p><b>P</b> 是可选的；P 表示有源输出放电功能。</p> <p><b>yyy</b> 为封装标识符。</p> <p><b>z</b> 为封装数量。R 表示卷（3000 片），T 表示带（250 片）。</p> |

- (1) 要获得最新的封装和订货信息，请参阅本文档末尾的封装选项附录，或者访问器件产品文件夹（[www.ti.com.cn](http://www.ti.com.cn)）。
- (2) 可提供 1.0V 至 3.3V 范围内的输出电压（以 50mV 为单位增量）。更多详细信息及可用性，请联系制造商。

### 11.2 文档支持

#### 11.2.1 相关文档

请参阅如下相关文档：

《[通用低压降 \(LDO\) 线性稳压器 MultiPkgLDOEVM-823 评估模块](#)》

#### 11.3 接收文档更新通知

要接收文档更新通知，请导航至 [TI.com.cn](http://TI.com.cn) 上的器件产品文件夹。单击右上角的 [通知我](#) 进行注册，即可每周接收产品信息更改摘要。有关更改的详细信息，请查看任何已修订文档中包含的修订历史记录。

### 11.4 社区资源

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ Online Community** *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At [e2e.ti.com](http://e2e.ti.com), you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 11.5 商标

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

### 11.6 静电放电警告



ESD 可能会损坏该集成电路。德州仪器 (TI) 建议通过适当的预防措施处理所有集成电路。如果不遵守正确的处理措施和安装程序，可能会损坏集成电路。

ESD 的损坏小至导致微小的性能降级，大至整个器件故障。精密的集成电路可能更容易受到损坏，这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

### 11.7 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 12 机械、封装和可订购信息

以下页面包含机械、封装和可订购信息。这些信息是指定器件的最新可用数据。数据如有变更，恕不另行通知，且不会对此文档进行修订。如需获取此数据表的浏览器版本，请查阅左侧的导航栏。

**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| TPS7A0508PDBVR   | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1C6F                    | <a href="#">Samples</a> |
| TPS7A0508PDBVT   | ACTIVE        | SOT-23       | DBV             | 5    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1C6F                    | <a href="#">Samples</a> |
| TPS7A0508PDBZR   | ACTIVE        | SOT-23       | DBZ             | 3    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1QMW                    | <a href="#">Samples</a> |
| TPS7A0508PDBZT   | ACTIVE        | SOT-23       | DBZ             | 3    | 250         | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1QMW                    | <a href="#">Samples</a> |
| TPS7A0508PDQNR   | ACTIVE        | X2SON        | DQN             | 4    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 6G                      | <a href="#">Samples</a> |
| TPS7A0508PDQNT   | ACTIVE        | X2SON        | DQN             | 4    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 6G                      | <a href="#">Samples</a> |
| TPS7A0508PYKAR   | ACTIVE        | DSBGA        | YKA             | 4    | 12000       | RoHS & Green    | SNAGCU                               | Level-1-260C-UNLIM   | -40 to 125   | 3                       | <a href="#">Samples</a> |
| TPS7A0510PDBVR   | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1IKF                    | <a href="#">Samples</a> |
| TPS7A0510PDBVT   | ACTIVE        | SOT-23       | DBV             | 5    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1IKF                    | <a href="#">Samples</a> |
| TPS7A0510PDQNR   | ACTIVE        | X2SON        | DQN             | 4    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | C7                      | <a href="#">Samples</a> |
| TPS7A0510PDQNT   | ACTIVE        | X2SON        | DQN             | 4    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | C7                      | <a href="#">Samples</a> |
| TPS7A0510PYKAR   | ACTIVE        | DSBGA        | YKA             | 4    | 12000       | RoHS & Green    | SNAGCU                               | Level-1-260C-UNLIM   | -40 to 125   | L                       | <a href="#">Samples</a> |
| TPS7A0511PDQNR   | ACTIVE        | X2SON        | DQN             | 4    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | HK                      | <a href="#">Samples</a> |
| TPS7A0512PDBVR   | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1ILF                    | <a href="#">Samples</a> |
| TPS7A0512PDBVT   | ACTIVE        | SOT-23       | DBV             | 5    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1ILF                    | <a href="#">Samples</a> |
| TPS7A0512PDBZR   | ACTIVE        | SOT-23       | DBZ             | 3    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1QOW                    | <a href="#">Samples</a> |
| TPS7A0512PDBZT   | ACTIVE        | SOT-23       | DBZ             | 3    | 250         | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1QOW                    | <a href="#">Samples</a> |
| TPS7A0512PDQNR   | ACTIVE        | X2SON        | DQN             | 4    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | C8                      | <a href="#">Samples</a> |
| TPS7A0512PDQNT   | ACTIVE        | X2SON        | DQN             | 4    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | C8                      | <a href="#">Samples</a> |
| TPS7A0512PYKAR   | ACTIVE        | DSBGA        | YKA             | 4    | 12000       | RoHS & Green    | SNAGCU                               | Level-1-260C-UNLIM   | -40 to 125   | M                       | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| TPS7A0515PDBVR   | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1IMF                    | <a href="#">Samples</a> |
| TPS7A0515PDBVT   | ACTIVE        | SOT-23       | DBV             | 5    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1IMF                    | <a href="#">Samples</a> |
| TPS7A0515PDQNR   | ACTIVE        | X2SON        | DQN             | 4    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | C9                      | <a href="#">Samples</a> |
| TPS7A0515PDQNT   | ACTIVE        | X2SON        | DQN             | 4    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | C9                      | <a href="#">Samples</a> |
| TPS7A0515PYKAR   | ACTIVE        | DSBGA        | YKA             | 4    | 12000       | RoHS & Green    | SNAGCU                               | Level-1-260C-UNLIM   | -40 to 125   | N                       | <a href="#">Samples</a> |
| TPS7A051825PYKAR | ACTIVE        | DSBGA        | YKA             | 4    | 12000       | RoHS & Green    | SNAGCU                               | Level-1-260C-UNLIM   | -40 to 125   | P                       | <a href="#">Samples</a> |
| TPS7A0518PDBVR   | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1INF                    | <a href="#">Samples</a> |
| TPS7A0518PDBVT   | ACTIVE        | SOT-23       | DBV             | 5    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1INF                    | <a href="#">Samples</a> |
| TPS7A0518PDBZR   | ACTIVE        | SOT-23       | DBZ             | 3    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1QQW                    | <a href="#">Samples</a> |
| TPS7A0518PDBZT   | ACTIVE        | SOT-23       | DBZ             | 3    | 250         | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1QQW                    | <a href="#">Samples</a> |
| TPS7A0518PDQNR   | ACTIVE        | X2SON        | DQN             | 4    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | CA                      | <a href="#">Samples</a> |
| TPS7A0518PDQNT   | ACTIVE        | X2SON        | DQN             | 4    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | CA                      | <a href="#">Samples</a> |
| TPS7A0518PYKAR   | ACTIVE        | DSBGA        | YKA             | 4    | 12000       | RoHS & Green    | SNAGCU                               | Level-1-260C-UNLIM   | -40 to 125   | P                       | <a href="#">Samples</a> |
| TPS7A0520PDBZR   | ACTIVE        | SOT-23       | DBZ             | 3    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1U8W                    | <a href="#">Samples</a> |
| TPS7A0520PDBZT   | ACTIVE        | SOT-23       | DBZ             | 3    | 250         | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1U8W                    | <a href="#">Samples</a> |
| TPS7A0520PDQNR   | ACTIVE        | X2SON        | DQN             | 4    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | G1                      | <a href="#">Samples</a> |
| TPS7A0522PDBVR   | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1P3F                    | <a href="#">Samples</a> |
| TPS7A0522PDBVT   | ACTIVE        | SOT-23       | DBV             | 5    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1P3F                    | <a href="#">Samples</a> |
| TPS7A0522PDBZR   | ACTIVE        | SOT-23       | DBZ             | 3    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1U9W                    | <a href="#">Samples</a> |
| TPS7A0522PDBZT   | ACTIVE        | SOT-23       | DBZ             | 3    | 250         | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1U9W                    | <a href="#">Samples</a> |
| TPS7A0525PDBVR   | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1IOF                    | <a href="#">Samples</a> |



| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| TPS7A0525PDBVT   | ACTIVE        | SOT-23       | DBV             | 5    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1IOF                    | <a href="#">Samples</a> |
| TPS7A0525PDQNR   | ACTIVE        | X2SON        | DQN             | 4    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | CB                      | <a href="#">Samples</a> |
| TPS7A0525PDQNT   | ACTIVE        | X2SON        | DQN             | 4    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | CB                      | <a href="#">Samples</a> |
| TPS7A0525PYKAR   | ACTIVE        | DSBGA        | YKA             | 4    | 12000       | RoHS & Green    | SNAGCU                               | Level-1-260C-UNLIM   | -40 to 125   | Q                       | <a href="#">Samples</a> |
| TPS7A0527PDBZR   | ACTIVE        | SOT-23       | DBZ             | 3    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1UAW                    | <a href="#">Samples</a> |
| TPS7A0527PDBZT   | ACTIVE        | SOT-23       | DBZ             | 3    | 250         | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1UAW                    | <a href="#">Samples</a> |
| TPS7A05285PDBVR  | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1IRF                    | <a href="#">Samples</a> |
| TPS7A05285PDBVT  | ACTIVE        | SOT-23       | DBV             | 5    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1IRF                    | <a href="#">Samples</a> |
| TPS7A05285PDQNR  | ACTIVE        | X2SON        | DQN             | 4    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | CC                      | <a href="#">Samples</a> |
| TPS7A05285PDQNT  | ACTIVE        | X2SON        | DQN             | 4    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | CC                      | <a href="#">Samples</a> |
| TPS7A05285PYKAR  | ACTIVE        | DSBGA        | YKA             | 4    | 12000       | RoHS & Green    | SNAGCU                               | Level-1-260C-UNLIM   | -40 to 125   | R                       | <a href="#">Samples</a> |
| TPS7A0528PDBZR   | ACTIVE        | SOT-23       | DBZ             | 3    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1QSW                    | <a href="#">Samples</a> |
| TPS7A0528PDBZT   | ACTIVE        | SOT-23       | DBZ             | 3    | 250         | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1QSW                    | <a href="#">Samples</a> |
| TPS7A0528PDQNR   | ACTIVE        | X2SON        | DQN             | 4    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | DH                      | <a href="#">Samples</a> |
| TPS7A0528PDQNT   | ACTIVE        | X2SON        | DQN             | 4    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | DH                      | <a href="#">Samples</a> |
| TPS7A0530PDBVR   | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1QWF                    | <a href="#">Samples</a> |
| TPS7A0530PDBVT   | ACTIVE        | SOT-23       | DBV             | 5    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1QWF                    | <a href="#">Samples</a> |
| TPS7A0530PDBZR   | ACTIVE        | SOT-23       | DBZ             | 3    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1QUW                    | <a href="#">Samples</a> |
| TPS7A0530PDBZT   | ACTIVE        | SOT-23       | DBZ             | 3    | 250         | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1QUW                    | <a href="#">Samples</a> |
| TPS7A0530PDQNR   | ACTIVE        | X2SON        | DQN             | 4    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | DG                      | <a href="#">Samples</a> |
| TPS7A0530PDQNT   | ACTIVE        | X2SON        | DQN             | 4    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | DG                      | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| TPS7A0530PYKAR   | ACTIVE        | DSBGA        | YKA             | 4    | 12000       | RoHS & Green    | SNAGCU                               | Level-1-260C-UNLIM   | -40 to 125   | W                       | <a href="#">Samples</a> |
| TPS7A0531PDBVR   | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1P4F                    | <a href="#">Samples</a> |
| TPS7A0531PDBVT   | ACTIVE        | SOT-23       | DBV             | 5    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1P4F                    | <a href="#">Samples</a> |
| TPS7A0531PDQNR   | ACTIVE        | X2SON        | DQN             | 4    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | I6                      | <a href="#">Samples</a> |
| TPS7A0533PDBVR   | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1IPF                    | <a href="#">Samples</a> |
| TPS7A0533PDBVT   | ACTIVE        | SOT-23       | DBV             | 5    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 1IPF                    | <a href="#">Samples</a> |
| TPS7A0533PDBZR   | ACTIVE        | SOT-23       | DBZ             | 3    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1QVW                    | <a href="#">Samples</a> |
| TPS7A0533PDBZT   | ACTIVE        | SOT-23       | DBZ             | 3    | 250         | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | 1QVW                    | <a href="#">Samples</a> |
| TPS7A0533PDQNR   | ACTIVE        | X2SON        | DQN             | 4    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | CD                      | <a href="#">Samples</a> |
| TPS7A0533PDQNT   | ACTIVE        | X2SON        | DQN             | 4    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | CD                      | <a href="#">Samples</a> |
| TPS7A0533PYKAR   | ACTIVE        | DSBGA        | YKA             | 4    | 12000       | RoHS & Green    | SNAGCU                               | Level-1-260C-UNLIM   | -40 to 125   | S                       | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

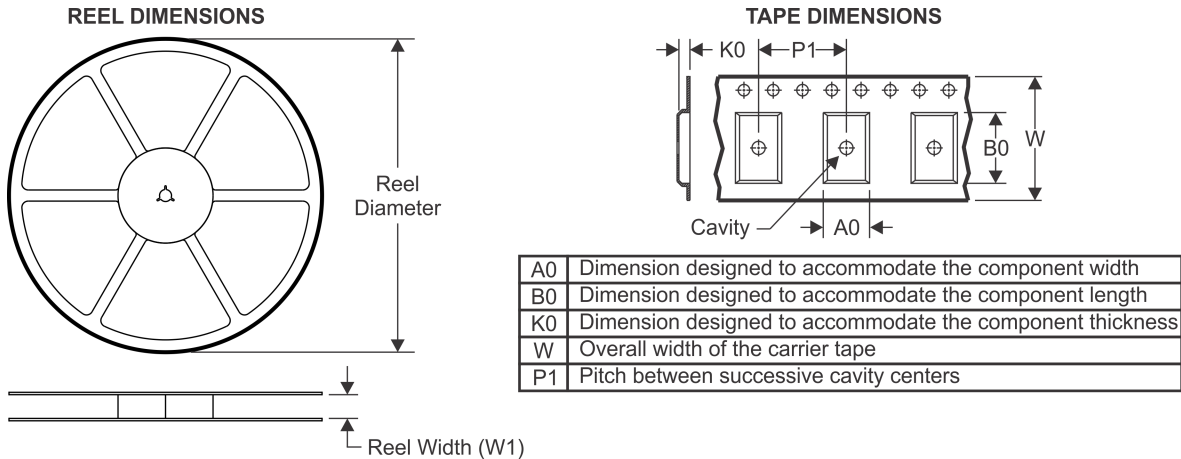
<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## TAPE AND REEL INFORMATION



### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

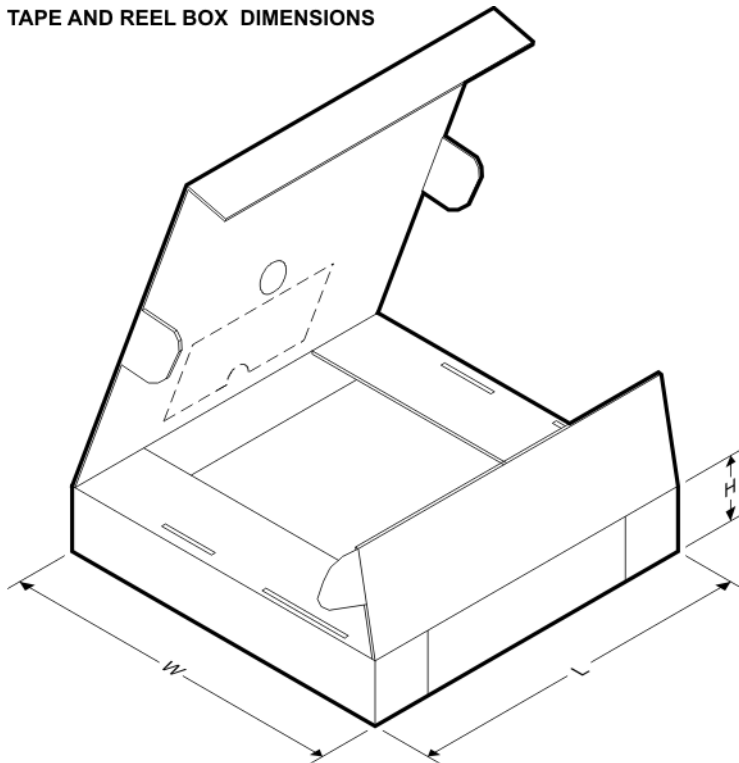


\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ   | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|-------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TPS7A0508PDBVR | SOT-23       | DBV             | 5    | 3000  | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A0508PDBVT | SOT-23       | DBV             | 5    | 250   | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A0508PDBZR | SOT-23       | DBZ             | 3    | 3000  | 178.0              | 9.0                | 3.15    | 2.77    | 1.22    | 4.0     | 8.0    | Q3            |
| TPS7A0508PDBZT | SOT-23       | DBZ             | 3    | 250   | 178.0              | 9.0                | 3.15    | 2.77    | 1.22    | 4.0     | 8.0    | Q3            |
| TPS7A0508PDQNR | X2SON        | DQN             | 4    | 3000  | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A0508PDQNT | X2SON        | DQN             | 4    | 250   | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A0508PYKAR | DSBGA        | YKA             | 4    | 12000 | 180.0              | 8.4                | 0.76    | 0.76    | 0.46    | 2.0     | 8.0    | Q1            |
| TPS7A0510PDBVR | SOT-23       | DBV             | 5    | 3000  | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A0510PDBVT | SOT-23       | DBV             | 5    | 250   | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A0510PDQNR | X2SON        | DQN             | 4    | 3000  | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A0510PDQNT | X2SON        | DQN             | 4    | 250   | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A0510PYKAR | DSBGA        | YKA             | 4    | 12000 | 180.0              | 8.4                | 0.76    | 0.76    | 0.46    | 2.0     | 8.0    | Q1            |
| TPS7A0511PDQNR | X2SON        | DQN             | 4    | 3000  | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A0512PDBVR | SOT-23       | DBV             | 5    | 3000  | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A0512PDBVT | SOT-23       | DBV             | 5    | 250   | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A0512PDBZR | SOT-23       | DBZ             | 3    | 3000  | 178.0              | 9.0                | 3.15    | 2.77    | 1.22    | 4.0     | 8.0    | Q3            |
| TPS7A0512PDBZT | SOT-23       | DBZ             | 3    | 250   | 178.0              | 9.0                | 3.15    | 2.77    | 1.22    | 4.0     | 8.0    | Q3            |
| TPS7A0512PDQNR | X2SON        | DQN             | 4    | 3000  | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |

| Device           | Package Type | Package Drawing | Pins | SPQ   | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|-------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TPS7A0512PDQNT   | X2SON        | DQN             | 4    | 250   | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A0512PYKAR   | DSBGA        | YKA             | 4    | 12000 | 180.0              | 8.4                | 0.76    | 0.76    | 0.46    | 2.0     | 8.0    | Q1            |
| TPS7A0515PDBVR   | SOT-23       | DBV             | 5    | 3000  | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A0515PDBVT   | SOT-23       | DBV             | 5    | 250   | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A0515PDQNR   | X2SON        | DQN             | 4    | 3000  | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A0515PDQNT   | X2SON        | DQN             | 4    | 250   | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A0515PYKAR   | DSBGA        | YKA             | 4    | 12000 | 180.0              | 8.4                | 0.76    | 0.76    | 0.46    | 2.0     | 8.0    | Q1            |
| TPS7A051825PYKAR | DSBGA        | YKA             | 4    | 12000 | 180.0              | 8.4                | 0.76    | 0.76    | 0.46    | 2.0     | 8.0    | Q1            |
| TPS7A0518PDBVR   | SOT-23       | DBV             | 5    | 3000  | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A0518PDBVT   | SOT-23       | DBV             | 5    | 250   | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A0518PDBZR   | SOT-23       | DBZ             | 3    | 3000  | 178.0              | 9.0                | 3.15    | 2.77    | 1.22    | 4.0     | 8.0    | Q3            |
| TPS7A0518PDBZT   | SOT-23       | DBZ             | 3    | 250   | 178.0              | 9.0                | 3.15    | 2.77    | 1.22    | 4.0     | 8.0    | Q3            |
| TPS7A0518PDQNR   | X2SON        | DQN             | 4    | 3000  | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A0518PDQNT   | X2SON        | DQN             | 4    | 250   | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A0518PYKAR   | DSBGA        | YKA             | 4    | 12000 | 180.0              | 8.4                | 0.76    | 0.76    | 0.46    | 2.0     | 8.0    | Q1            |
| TPS7A0520PDBZR   | SOT-23       | DBZ             | 3    | 3000  | 178.0              | 9.0                | 3.15    | 2.77    | 1.22    | 4.0     | 8.0    | Q3            |
| TPS7A0520PDBZT   | SOT-23       | DBZ             | 3    | 250   | 178.0              | 9.0                | 3.15    | 2.77    | 1.22    | 4.0     | 8.0    | Q3            |
| TPS7A0520PDQNR   | X2SON        | DQN             | 4    | 3000  | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A0522PDBVR   | SOT-23       | DBV             | 5    | 3000  | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A0522PDBVT   | SOT-23       | DBV             | 5    | 250   | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A0522PDBZR   | SOT-23       | DBZ             | 3    | 3000  | 178.0              | 9.0                | 3.15    | 2.77    | 1.22    | 4.0     | 8.0    | Q3            |
| TPS7A0522PDBZT   | SOT-23       | DBZ             | 3    | 250   | 178.0              | 9.0                | 3.15    | 2.77    | 1.22    | 4.0     | 8.0    | Q3            |
| TPS7A0525PDBVR   | SOT-23       | DBV             | 5    | 3000  | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A0525PDBVT   | SOT-23       | DBV             | 5    | 250   | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A0525PDQNR   | X2SON        | DQN             | 4    | 3000  | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A0525PDQNT   | X2SON        | DQN             | 4    | 250   | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A0525PYKAR   | DSBGA        | YKA             | 4    | 12000 | 180.0              | 8.4                | 0.76    | 0.76    | 0.46    | 2.0     | 8.0    | Q1            |
| TPS7A0527PDBZR   | SOT-23       | DBZ             | 3    | 3000  | 178.0              | 9.0                | 3.15    | 2.77    | 1.22    | 4.0     | 8.0    | Q3            |
| TPS7A0527PDBZT   | SOT-23       | DBZ             | 3    | 250   | 178.0              | 9.0                | 3.15    | 2.77    | 1.22    | 4.0     | 8.0    | Q3            |
| TPS7A05285PDBVR  | SOT-23       | DBV             | 5    | 3000  | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A05285PDBVT  | SOT-23       | DBV             | 5    | 250   | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A05285PDQNR  | X2SON        | DQN             | 4    | 3000  | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A05285PDQNT  | X2SON        | DQN             | 4    | 250   | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A05285PYKAR  | DSBGA        | YKA             | 4    | 12000 | 180.0              | 8.4                | 0.76    | 0.76    | 0.46    | 2.0     | 8.0    | Q1            |
| TPS7A0528PDBZR   | SOT-23       | DBZ             | 3    | 3000  | 178.0              | 9.0                | 3.15    | 2.77    | 1.22    | 4.0     | 8.0    | Q3            |
| TPS7A0528PDBZT   | SOT-23       | DBZ             | 3    | 250   | 178.0              | 9.0                | 3.15    | 2.77    | 1.22    | 4.0     | 8.0    | Q3            |
| TPS7A0528PDQNR   | X2SON        | DQN             | 4    | 3000  | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A0528PDQNT   | X2SON        | DQN             | 4    | 250   | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A0530PDBVR   | SOT-23       | DBV             | 5    | 3000  | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A0530PDBVT   | SOT-23       | DBV             | 5    | 250   | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A0530PDBZR   | SOT-23       | DBZ             | 3    | 3000  | 178.0              | 9.0                | 3.15    | 2.77    | 1.22    | 4.0     | 8.0    | Q3            |
| TPS7A0530PDBZT   | SOT-23       | DBZ             | 3    | 250   | 178.0              | 9.0                | 3.15    | 2.77    | 1.22    | 4.0     | 8.0    | Q3            |
| TPS7A0530PDQNR   | X2SON        | DQN             | 4    | 3000  | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |

| Device         | Package Type | Package Drawing | Pins | SPQ   | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|-------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TPS7A0530PDQNT | X2SON        | DQN             | 4    | 250   | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A0530PYKAR | DSBGA        | YKA             | 4    | 12000 | 180.0              | 8.4                | 0.76    | 0.76    | 0.46    | 2.0     | 8.0    | Q1            |
| TPS7A0531PDBVR | SOT-23       | DBV             | 5    | 3000  | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A0531PDBVT | SOT-23       | DBV             | 5    | 250   | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A0531PDQNR | X2SON        | DQN             | 4    | 3000  | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A0533PDBVR | SOT-23       | DBV             | 5    | 3000  | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A0533PDBVT | SOT-23       | DBV             | 5    | 250   | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS7A0533PDBZR | SOT-23       | DBZ             | 3    | 3000  | 178.0              | 9.0                | 3.15    | 2.77    | 1.22    | 4.0     | 8.0    | Q3            |
| TPS7A0533PDBZT | SOT-23       | DBZ             | 3    | 250   | 178.0              | 9.0                | 3.15    | 2.77    | 1.22    | 4.0     | 8.0    | Q3            |
| TPS7A0533PDQNR | X2SON        | DQN             | 4    | 3000  | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A0533PDQNT | X2SON        | DQN             | 4    | 250   | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| TPS7A0533PYKAR | DSBGA        | YKA             | 4    | 12000 | 180.0              | 8.4                | 0.76    | 0.76    | 0.46    | 2.0     | 8.0    | Q1            |

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS7A0508PDBVR | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS7A0508PDBVT | SOT-23       | DBV             | 5    | 250  | 210.0       | 185.0      | 35.0        |
| TPS7A0508PDBZR | SOT-23       | DBZ             | 3    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS7A0508PDBZT | SOT-23       | DBZ             | 3    | 250  | 180.0       | 180.0      | 18.0        |
| TPS7A0508PDQNR | X2SON        | DQN             | 4    | 3000 | 184.0       | 184.0      | 19.0        |

| Device           | Package Type | Package Drawing | Pins | SPQ   | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|-------|-------------|------------|-------------|
| TPS7A0508PDQNT   | X2SON        | DQN             | 4    | 250   | 184.0       | 184.0      | 19.0        |
| TPS7A0508PYKAR   | DSBGA        | YKA             | 4    | 12000 | 182.0       | 182.0      | 20.0        |
| TPS7A0510PDBVR   | SOT-23       | DBV             | 5    | 3000  | 210.0       | 185.0      | 35.0        |
| TPS7A0510PDBVT   | SOT-23       | DBV             | 5    | 250   | 210.0       | 185.0      | 35.0        |
| TPS7A0510PDQNR   | X2SON        | DQN             | 4    | 3000  | 184.0       | 184.0      | 19.0        |
| TPS7A0510PDQNT   | X2SON        | DQN             | 4    | 250   | 184.0       | 184.0      | 19.0        |
| TPS7A0510PYKAR   | DSBGA        | YKA             | 4    | 12000 | 182.0       | 182.0      | 20.0        |
| TPS7A0511PDQNR   | X2SON        | DQN             | 4    | 3000  | 184.0       | 184.0      | 19.0        |
| TPS7A0512PDBVR   | SOT-23       | DBV             | 5    | 3000  | 210.0       | 185.0      | 35.0        |
| TPS7A0512PDBVT   | SOT-23       | DBV             | 5    | 250   | 210.0       | 185.0      | 35.0        |
| TPS7A0512PDBZR   | SOT-23       | DBZ             | 3    | 3000  | 180.0       | 180.0      | 18.0        |
| TPS7A0512PDBZT   | SOT-23       | DBZ             | 3    | 250   | 180.0       | 180.0      | 18.0        |
| TPS7A0512PDQNR   | X2SON        | DQN             | 4    | 3000  | 184.0       | 184.0      | 19.0        |
| TPS7A0512PDQNT   | X2SON        | DQN             | 4    | 250   | 184.0       | 184.0      | 19.0        |
| TPS7A0512PYKAR   | DSBGA        | YKA             | 4    | 12000 | 182.0       | 182.0      | 20.0        |
| TPS7A0515PDBVR   | SOT-23       | DBV             | 5    | 3000  | 210.0       | 185.0      | 35.0        |
| TPS7A0515PDBVT   | SOT-23       | DBV             | 5    | 250   | 210.0       | 185.0      | 35.0        |
| TPS7A0515PDQNR   | X2SON        | DQN             | 4    | 3000  | 184.0       | 184.0      | 19.0        |
| TPS7A0515PDQNT   | X2SON        | DQN             | 4    | 250   | 184.0       | 184.0      | 19.0        |
| TPS7A0515PYKAR   | DSBGA        | YKA             | 4    | 12000 | 182.0       | 182.0      | 20.0        |
| TPS7A051825PYKAR | DSBGA        | YKA             | 4    | 12000 | 182.0       | 182.0      | 20.0        |
| TPS7A0518PDBVR   | SOT-23       | DBV             | 5    | 3000  | 210.0       | 185.0      | 35.0        |
| TPS7A0518PDBVT   | SOT-23       | DBV             | 5    | 250   | 210.0       | 185.0      | 35.0        |
| TPS7A0518PDBZR   | SOT-23       | DBZ             | 3    | 3000  | 180.0       | 180.0      | 18.0        |
| TPS7A0518PDBZT   | SOT-23       | DBZ             | 3    | 250   | 180.0       | 180.0      | 18.0        |
| TPS7A0518PDQNR   | X2SON        | DQN             | 4    | 3000  | 184.0       | 184.0      | 19.0        |
| TPS7A0518PDQNT   | X2SON        | DQN             | 4    | 250   | 184.0       | 184.0      | 19.0        |
| TPS7A0518PYKAR   | DSBGA        | YKA             | 4    | 12000 | 182.0       | 182.0      | 20.0        |
| TPS7A0520PDBZR   | SOT-23       | DBZ             | 3    | 3000  | 180.0       | 180.0      | 18.0        |
| TPS7A0520PDBZT   | SOT-23       | DBZ             | 3    | 250   | 180.0       | 180.0      | 18.0        |
| TPS7A0520PDQNR   | X2SON        | DQN             | 4    | 3000  | 184.0       | 184.0      | 19.0        |
| TPS7A0522PDBVR   | SOT-23       | DBV             | 5    | 3000  | 210.0       | 185.0      | 35.0        |
| TPS7A0522PDBVT   | SOT-23       | DBV             | 5    | 250   | 210.0       | 185.0      | 35.0        |
| TPS7A0522PDBZR   | SOT-23       | DBZ             | 3    | 3000  | 180.0       | 180.0      | 18.0        |
| TPS7A0522PDBZT   | SOT-23       | DBZ             | 3    | 250   | 180.0       | 180.0      | 18.0        |
| TPS7A0525PDBVR   | SOT-23       | DBV             | 5    | 3000  | 210.0       | 185.0      | 35.0        |
| TPS7A0525PDBVT   | SOT-23       | DBV             | 5    | 250   | 210.0       | 185.0      | 35.0        |
| TPS7A0525PDQNR   | X2SON        | DQN             | 4    | 3000  | 184.0       | 184.0      | 19.0        |
| TPS7A0525PDQNT   | X2SON        | DQN             | 4    | 250   | 184.0       | 184.0      | 19.0        |
| TPS7A0525PYKAR   | DSBGA        | YKA             | 4    | 12000 | 182.0       | 182.0      | 20.0        |
| TPS7A0527PDBZR   | SOT-23       | DBZ             | 3    | 3000  | 180.0       | 180.0      | 18.0        |
| TPS7A0527PDBZT   | SOT-23       | DBZ             | 3    | 250   | 180.0       | 180.0      | 18.0        |
| TPS7A05285PDBVR  | SOT-23       | DBV             | 5    | 3000  | 210.0       | 185.0      | 35.0        |
| TPS7A05285PDBVT  | SOT-23       | DBV             | 5    | 250   | 210.0       | 185.0      | 35.0        |

| Device          | Package Type | Package Drawing | Pins | SPQ   | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|-------|-------------|------------|-------------|
| TPS7A05285PDQNR | X2SON        | DQN             | 4    | 3000  | 184.0       | 184.0      | 19.0        |
| TPS7A05285PDQNT | X2SON        | DQN             | 4    | 250   | 184.0       | 184.0      | 19.0        |
| TPS7A05285PYKAR | DSBGA        | YKA             | 4    | 12000 | 182.0       | 182.0      | 20.0        |
| TPS7A0528PDBZR  | SOT-23       | DBZ             | 3    | 3000  | 180.0       | 180.0      | 18.0        |
| TPS7A0528PDBZT  | SOT-23       | DBZ             | 3    | 250   | 180.0       | 180.0      | 18.0        |
| TPS7A0528PDQNR  | X2SON        | DQN             | 4    | 3000  | 184.0       | 184.0      | 19.0        |
| TPS7A0528PDQNT  | X2SON        | DQN             | 4    | 250   | 184.0       | 184.0      | 19.0        |
| TPS7A0530PDBVR  | SOT-23       | DBV             | 5    | 3000  | 210.0       | 185.0      | 35.0        |
| TPS7A0530PDBVT  | SOT-23       | DBV             | 5    | 250   | 210.0       | 185.0      | 35.0        |
| TPS7A0530PDBZR  | SOT-23       | DBZ             | 3    | 3000  | 180.0       | 180.0      | 18.0        |
| TPS7A0530PDBZT  | SOT-23       | DBZ             | 3    | 250   | 180.0       | 180.0      | 18.0        |
| TPS7A0530PDQNR  | X2SON        | DQN             | 4    | 3000  | 184.0       | 184.0      | 19.0        |
| TPS7A0530PDQNT  | X2SON        | DQN             | 4    | 250   | 184.0       | 184.0      | 19.0        |
| TPS7A0530PYKAR  | DSBGA        | YKA             | 4    | 12000 | 182.0       | 182.0      | 20.0        |
| TPS7A0531PDBVR  | SOT-23       | DBV             | 5    | 3000  | 210.0       | 185.0      | 35.0        |
| TPS7A0531PDBVT  | SOT-23       | DBV             | 5    | 250   | 210.0       | 185.0      | 35.0        |
| TPS7A0531PDQNR  | X2SON        | DQN             | 4    | 3000  | 184.0       | 184.0      | 19.0        |
| TPS7A0533PDBVR  | SOT-23       | DBV             | 5    | 3000  | 210.0       | 185.0      | 35.0        |
| TPS7A0533PDBVT  | SOT-23       | DBV             | 5    | 250   | 210.0       | 185.0      | 35.0        |
| TPS7A0533PDBZR  | SOT-23       | DBZ             | 3    | 3000  | 180.0       | 180.0      | 18.0        |
| TPS7A0533PDBZT  | SOT-23       | DBZ             | 3    | 250   | 180.0       | 180.0      | 18.0        |
| TPS7A0533PDQNR  | X2SON        | DQN             | 4    | 3000  | 184.0       | 184.0      | 19.0        |
| TPS7A0533PDQNT  | X2SON        | DQN             | 4    | 250   | 184.0       | 184.0      | 19.0        |
| TPS7A0533PYKAR  | DSBGA        | YKA             | 4    | 12000 | 182.0       | 182.0      | 20.0        |



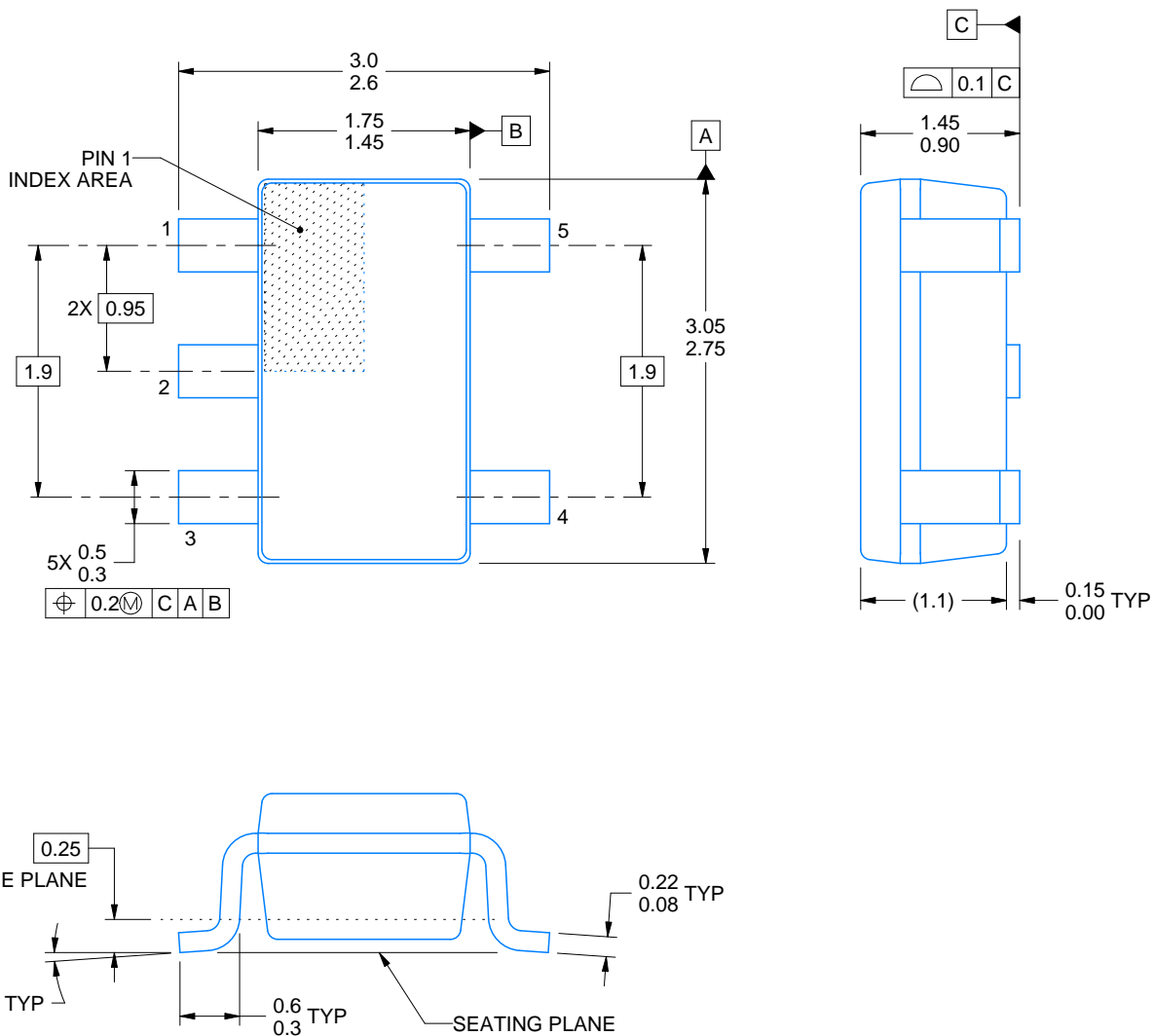


# DBV0005A

## PACKAGE OUTLINE

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



4214839/F 06/2021

### NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC MO-178.
4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.

# EXAMPLE BOARD LAYOUT

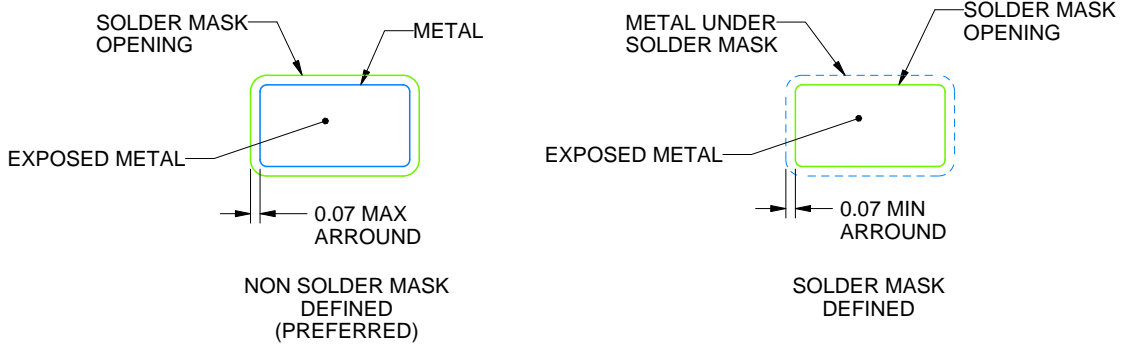
DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

4214839/F 06/2021

NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

4214839/F 06/2021

NOTES: (continued)

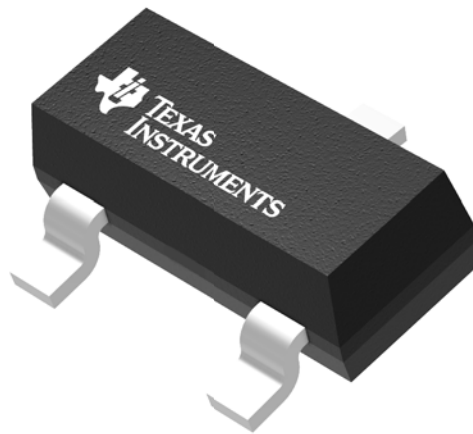
7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

## GENERIC PACKAGE VIEW

**DBZ 3**

**SOT-23 - 1.12 mm max height**

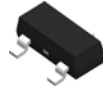
SMALL OUTLINE TRANSISTOR



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4203227/C

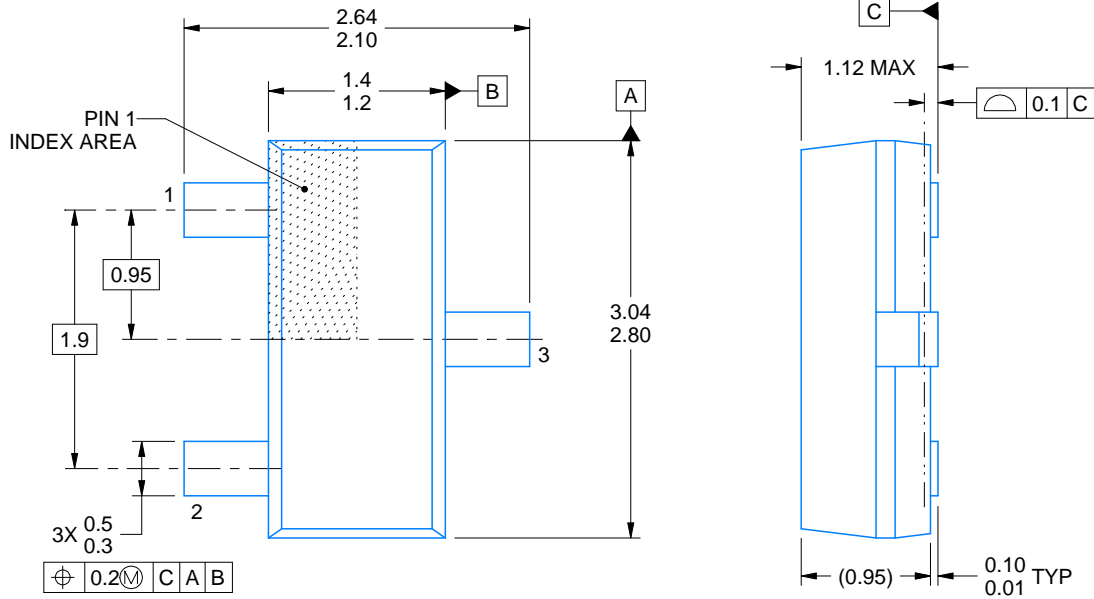
DBZ0003A



# PACKAGE OUTLINE

SOT-23 - 1.12 mm max height

SMALL OUTLINE TRANSISTOR



4214838/C 04/2017

NOTES:

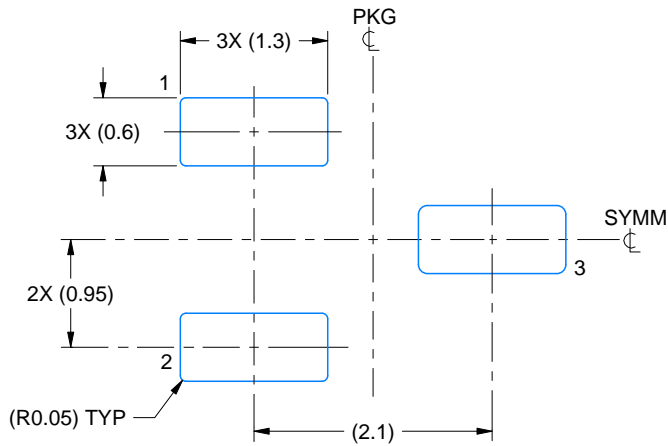
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC registration TO-236, except minimum foot length.

# EXAMPLE BOARD LAYOUT

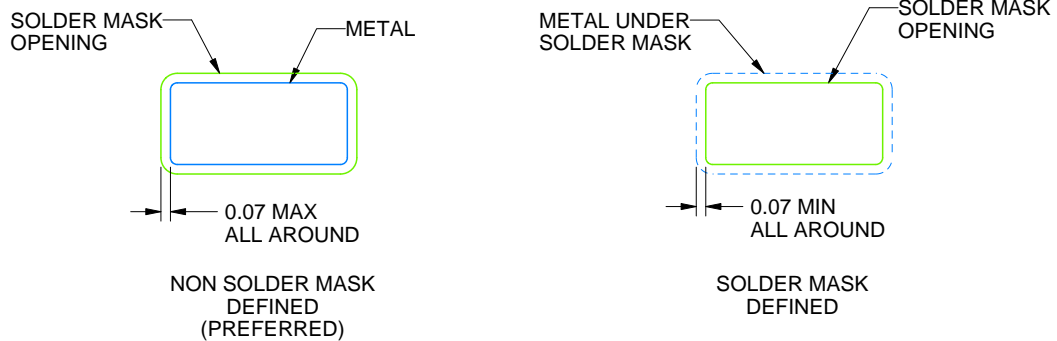
DBZ0003A

SOT-23 - 1.12 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
SCALE:15X



SOLDER MASK DETAILS

4214838/C 04/2017

NOTES: (continued)

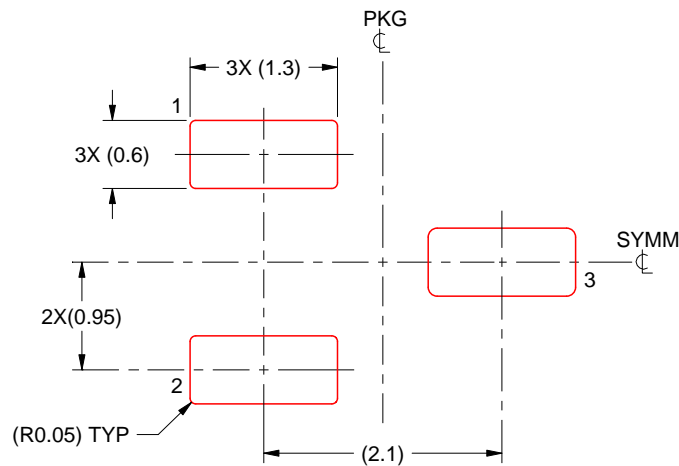
4. Publication IPC-7351 may have alternate designs.
5. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DBZ0003A

SOT-23 - 1.12 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 THICK STENCIL  
SCALE:15X

4214838/C 04/2017

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
7. Board assembly site may have different recommendations for stencil design.

## GENERIC PACKAGE VIEW

DQN 4

**X2SON - 0.4 mm max height**

PLASTIC SMALL OUTLINE - NO LEAD



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4210367/F

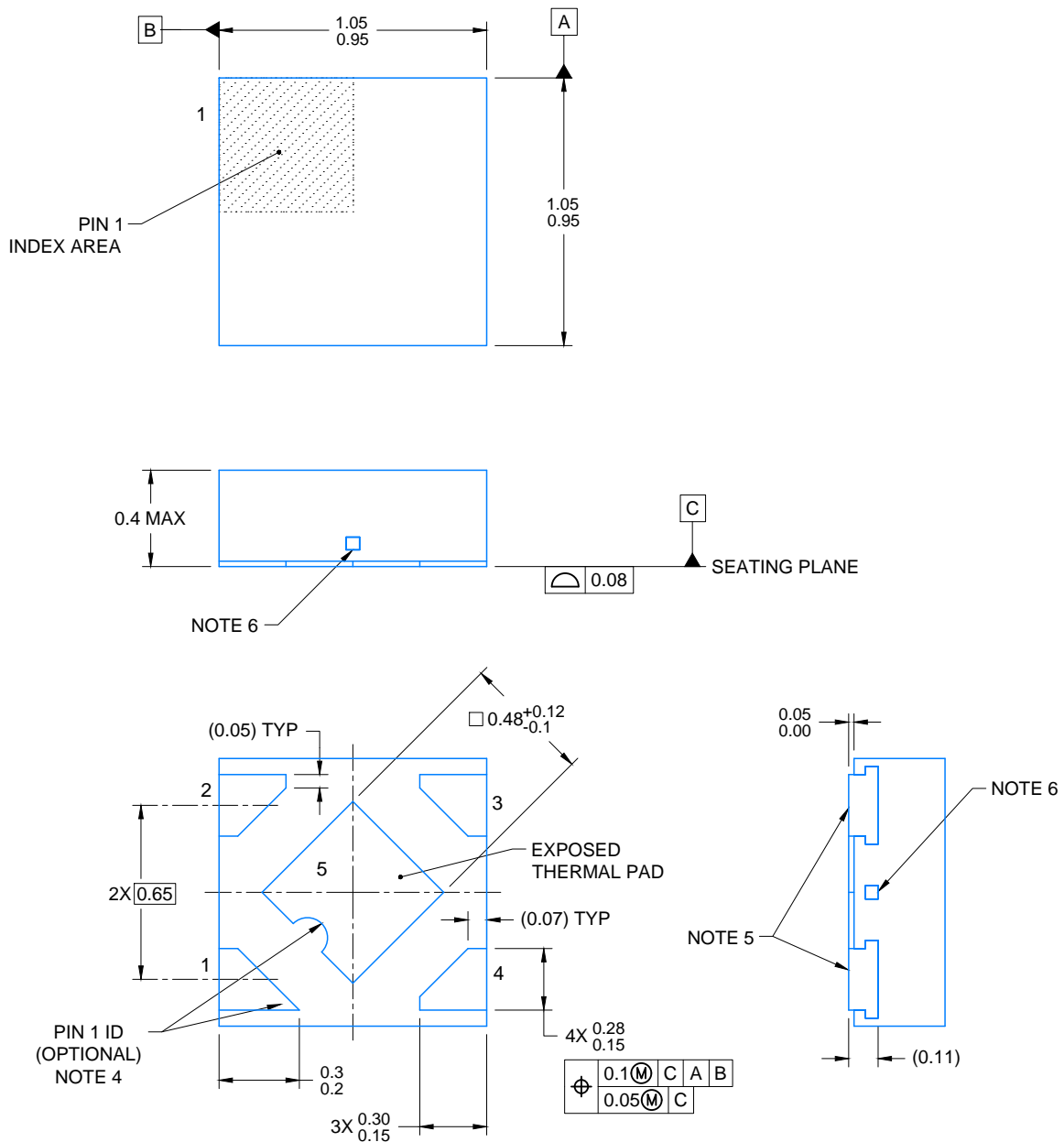


**DQN0004A**

**PACKAGE OUTLINE**

**X2SON - 0.4 mm max height**

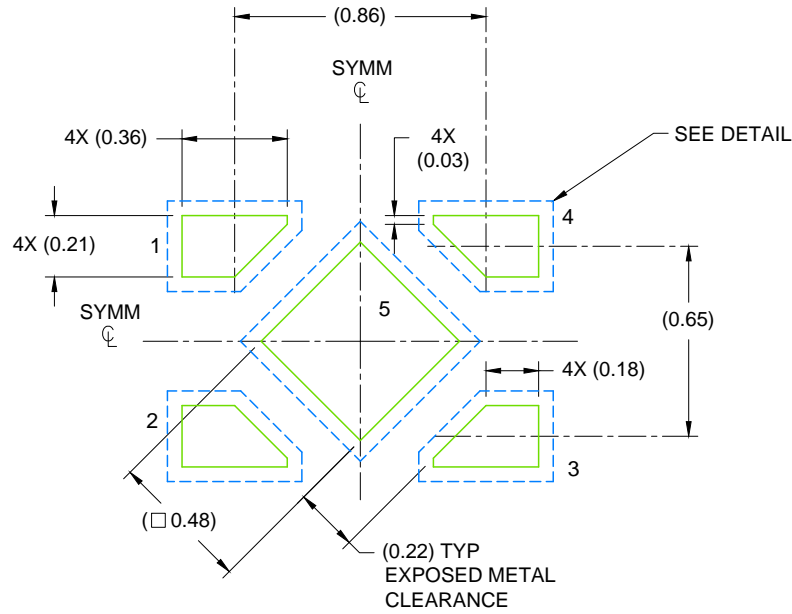
PLASTIC SMALL OUTLINE - NO LEAD



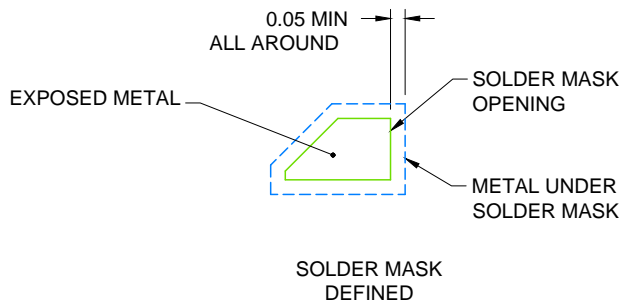
4215302/E 12/2016

**NOTES:**

- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- This drawing is subject to change without notice.
- The package thermal pad must be soldered to the printed circuit board for optimal thermal and mechanical performance.
- Features may not exist. Recommend use of pin 1 marking on top of package for orientation purposes.
- Shape of exposed side leads may differ.
- Number and location of exposed tie bars may vary.



LAND PATTERN EXAMPLE  
SCALE: 40X

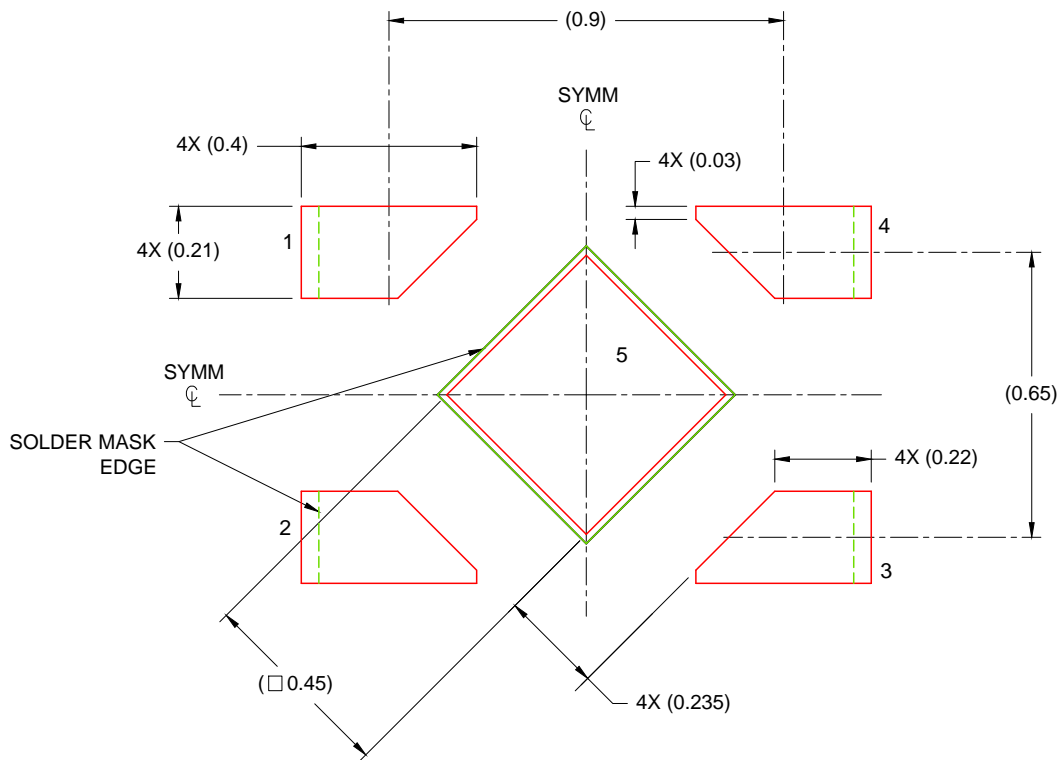


SOLDER MASK DETAIL

4215302/E 12/2016

NOTES: (continued)

7. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).
8. If any vias are implemented, it is recommended that vias under paste be filled, plugged or tented.



SOLDER PASTE EXAMPLE  
 BASED ON 0.075 - 0.1mm THICK STENCIL  
 EXPOSED PAD  
 88% PRINTED SOLDER COVERAGE BY AREA  
 SCALE: 60X

4215302/E 12/2016

NOTES: (continued)

- 9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

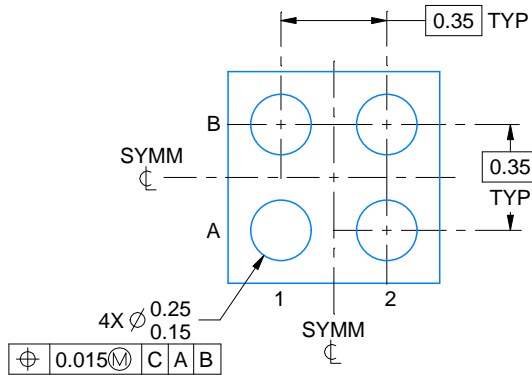
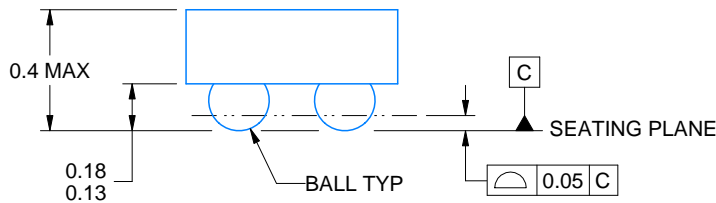
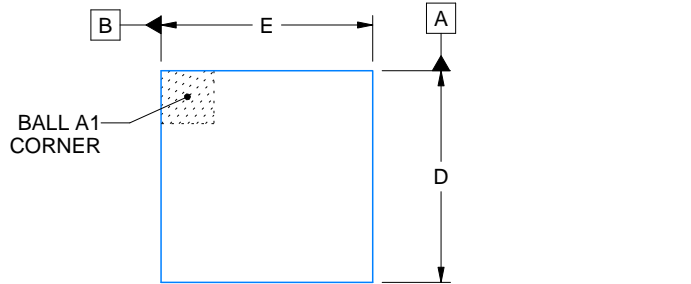
YKA0004



# PACKAGE OUTLINE

## DSBGA - 0.4 mm max height

DIE SIZE BALL GRID ARRAY



D: Max = 0.694 mm, Min = 0.634 mm  
E: Max = 0.694 mm, Min = 0.634 mm

4221909/B 08/2018

NOTES:

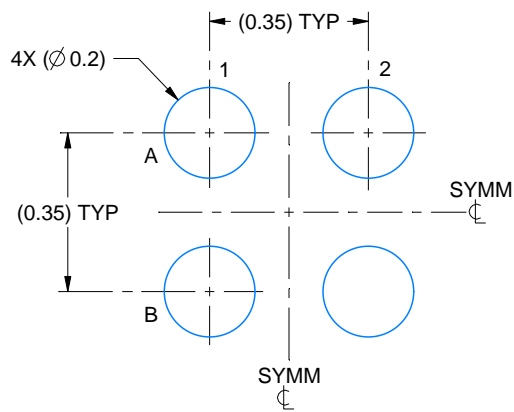
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

# EXAMPLE BOARD LAYOUT

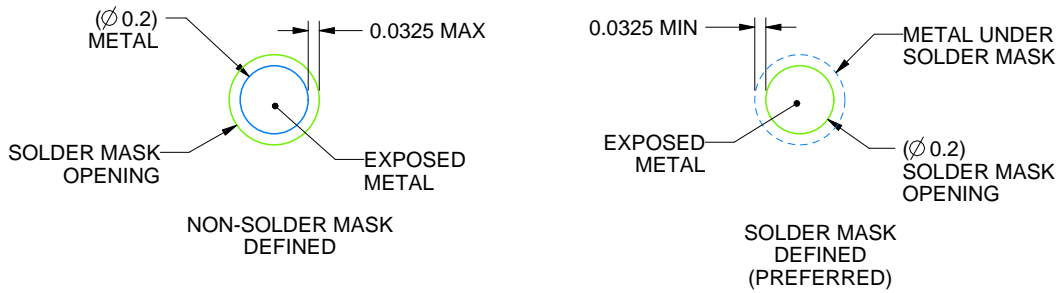
YKA0004

DSBGA - 0.4 mm max height

DIE SIZE BALL GRID ARRAY



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:60X



SOLDER MASK DETAILS  
NOT TO SCALE

4221909/B 08/2018

NOTES: (continued)

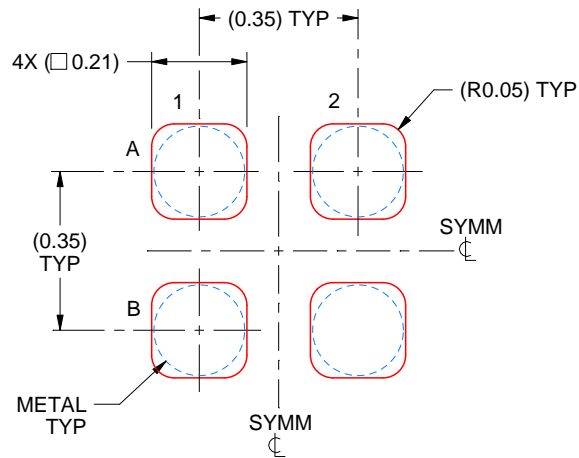
- Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For more information, see Texas Instruments literature number SNVA009 ([www.ti.com/lit/snva009](http://www.ti.com/lit/snva009)).

# EXAMPLE STENCIL DESIGN

YKA0004

DSBGA - 0.4 mm max height

DIE SIZE BALL GRID ARRAY



SOLDER PASTE EXAMPLE  
BASED ON 0.075 mm - 0.1 mm THICK STENCIL  
SCALE:60X

4221909/B 08/2018

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.

## 重要声明和免责声明

TI“按原样”提供技术和可靠性数据（包括数据表）、设计资源（包括参考设计）、应用或其他设计建议、网络工具、安全信息和其他资源，不保证没有瑕疵且不做任何明示或暗示的担保，包括但不限于对适销性、某特定用途方面的适用性或不侵犯任何第三方知识产权的暗示担保。

这些资源可供使用 TI 产品进行设计的熟练开发人员使用。您将自行承担以下全部责任：(1) 针对您的应用选择合适的 TI 产品，(2) 设计、验证并测试您的应用，(3) 确保您的应用满足相应标准以及任何其他功能安全、信息安全、监管或其他要求。

这些资源如有变更，恕不另行通知。TI 授权您仅可将这些资源用于研发本资源所述的 TI 产品的应用。严禁对这些资源进行其他复制或展示。您无权使用任何其他 TI 知识产权或任何第三方知识产权。您应全额赔偿因在这些资源的使用中对 TI 及其代表造成的任何索赔、损害、成本、损失和债务，TI 对此概不负责。

TI 提供的产品受 [TI 的销售条款](#) 或 [ti.com](#) 上其他适用条款/TI 产品随附的其他适用条款的约束。TI 提供这些资源并不会扩展或以其他方式更改 TI 针对 TI 产品发布的适用的担保或担保免责声明。

TI 反对并拒绝您可能提出的任何其他或不同的条款。

邮寄地址：Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2021，德州仪器 (TI) 公司